



# **SED**

## **Student Experiment Documentation**

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Mission: REXUS16

**Team Name: MOXA** 

Experiment Title: Measurement of Ozone and Oxygen in the Atmosphere

Team	Name	University
Student Team Leader:	Alexander Mager	TU Dresden
Team Members:	Bastian Klose	TU Dresden
	Patrick Geigengack	TU Dresden
	Alexander Schultze	TU Dresden
	Jonas Uhlmann	TU Dresden
	Daniel Becker	TU Dresden
	Fabienne Kinzelmann	TU Dresden
	Susann Knapik	TU Dresden
	Nathanael Warth	TU Dresden
	Max Oswald	TU Dresden
	Sebastian Weixler	TU Dresden

Issued by: Team MOXA

Approved by: Alexander Mager

Max Oswald Bastian Klose

# **Change Record**

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#### Abstract:

REXUS or BEXUS, SED - Student Experiment Documentation, MOXA - Measurement of Oxygen and Ozone in the Atmosphere, Atomic Oxygen, TU Dresden

Keywords:

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#### **PREFACE**

This Documentation describes the experiment and configuration of the MOXA experiment for the Rexus 15/16 sound rocket. The idea followed the development of new sensors at the Institute for Aerospace Engineering, Dresden University of Technology, lead by Dr. Tino Schmiel. We want to thank the institute for all the support given to us and the DLR/Esrange for this unique opportunity.

# **File Naming**

The naming convention for the SED is as follows:

- BX for BEXUS or RX for REXUS, plus number of flight
- MOXA for Measurement of Ozone and Oxygen in the Atmosphere
- FIPEX "Flux-(Φ-Phi)-Probe-Experiments"
- SED, plus version (e.g. 3 for CDR) and issue number (beginning with 0 and increasing number when a new issue is sent)
- Date of issue in format ddmmyy



#### **ABSTRACT**

The models of the distribution of residual gases varies widely. For instance the atomic oxygen models results differ up to 400%. To predict climate it is important to know the distribution of Oxygen in its various forms. For instance, atomic oxygen is a major influence on space borne objects, resulting in degradation of exposed materials.

Therefore the MOXA experiment will measure ozone, atomic and molecular oxygen, temperature and pressure during the flight. The Institute for Aerospace Engineering at Dresden University of Technology has developed innovative sensors for oxygen and ozone with a very low response time and high measurement accuracy. The atomic oxygen sensors of the experiment FIPEX have already performed successful measurements onboard the International Space Station and will be integrated in the experiment in a new miniaturized form.

The newly developed ozone sensor will be tested by comparing the measured data during the flight, in dependence of the pressure with existing data.

In addition the data of the oxygen measurements give a hint on the ozone values and will help to verify functionality of the ozone sensor.

The development of accurate sensors for residual gases contributes to the survey of the atmosphere to correlate existing atmospheric models. So it is possible to make precise prediction of residual gases.

This will support atmospheric science and improve the preparation of planned long term missions in the LEO.

The sensors are also applied in many other sections, for example breathing gas analysis.



#### 1 INTRODUCTION

## 1.1 Scientific/Technical Background

#### Scientific background:

Earth is "breathing".

The Atmosphere of earth is a dynamic and complex system which changes permanent and depend on different influences.

The most important one is the electromagnetic radiation of the sun which leads to photo dissociation, temperature variations and many other effects.

Other Influences are atmospheric tide effects, geomagnetism and up to now not cleared up variations.

Depending on wavelength (320 nm <  $\lambda$  < 1180 nm) ozone reacts to molecular and atomic. Because of the temperature variation and the gravitational field atomic oxygen diffuse to a higher altitude and recombine again when the radiation relieving Then the oxygen fall down again.

Due to the reduction of molecular oxygen and the diffusion of the atomic oxygen, in the altitude of 450 km atomic oxygen comes about 90 percent.

So the daily and annual variation of the sun radiation on a certain place on earth leads to significant changes of chemical composition in the atmosphere.

Atmospheric models were developed to predict densities, temperature and pressure in different altitudes for different longitudes and latitudes.

These models differ on the theoretical assumption, used data sources and needed input parameter.

## Atmospheric models

#### NRLMSISE-00:

MSIS (Mass Spectrometer and Incoherent Scatter) is an empiric model that is based on mass spectrometer data and pressure measurements of rockets, satellites and airplanes as well as on temperature measurements of incoherent scatter radars.

By addition of new data and combination with physical models the MSIS model has been developed to the NRLMSISE-00 (Naval Research Laboratory Mass Spectrometer and Incoherent Scatter) model. It predicts from sea level to the exosphere.

#### DTM:

The DTM model (Drag Temperature model) uses optical temperature measurements and data of atmospheric drag from satellites. It works with the assumption that helium, nitrogen and oxygen are the essential elements of the



atmosphere from 120 km to higher altitude and connect them with diffusion equations.

#### MET-2.0:

The MET model (Marshall Engineering Thermosphere Model) has edge condition of temperature and gas composition of 90km and based on diffusion equations and temperature assumptions to the altitude where data from satellite retardation exist.

## Prediction of atomic and molecular oxygen

We calculated a prediction of atomic and molecular oxygen to an altitude of 340 km for longitude and latitude of 0 degree for the year 2012, based on these three models. We used SPENVIS (ESA, European Space Agency, Space Environment Information System) for the calculation and the input parameters from the NOAA database.

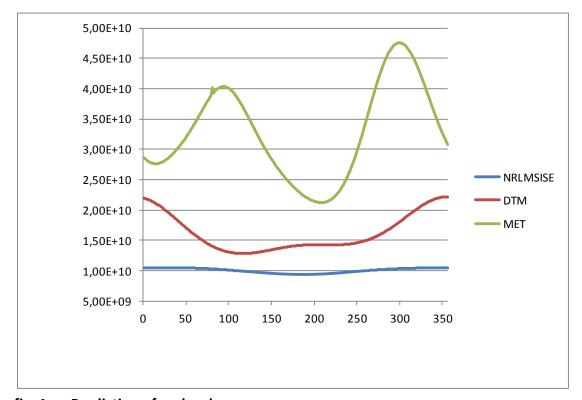


fig. 1: Prediction of molecular oxygen

In the prediction of molecular Oxygen the MET model shows a strong influence of the seasons.

The DTM model predicts a higher density for the beginning and end of the year and the in NRLMSISE model are no significant variations visible.

The values differ a lot from day to day.



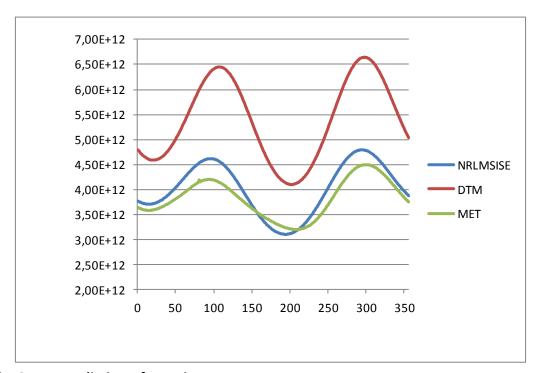


fig. 2: Prediction of atomic oxygen

In the prediction of atomic oxygen every model shows a clear influence of the seasons.

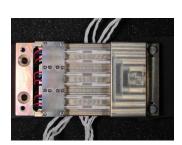
This comparison shows that these models are insufficient for a clear prediction. It is necessary to take time-resolved measurements of the densities of the gases in the atmosphere. That is a reason why these sensors have been developed.

The aim is to correlate one model or prospect up to now unknown influences and create a new model for calculating a precise prediction.



#### The sensors

First time resolved measurements of atomic and molecular oxygen were taken by the Flux- $(\Phi$ -Phi)-Probe-Experiments (FIPEX). It operated 572 days on European Technology Exposure Facility (EUTEF) on the International Space Station (ISS), fulfilled its primary objectives and collected complete reasonable data.



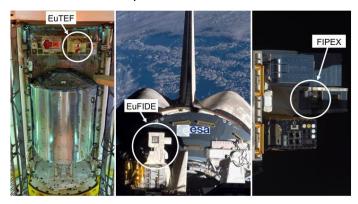


fig. 3: FIPEX

These AO and O2 sensors and in addition the new ozone sensor will operate in our experiment in a miniaturized form.

They are solid electrolyte sensors based on amperometric combined with the potentiometric-Nernst-principle for polarization control.

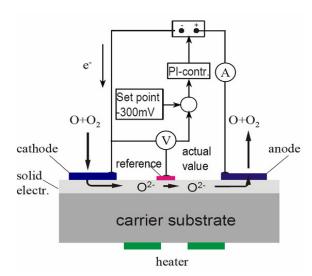


fig. 4: Amperometric principle for the AO sensor

Simplified cathode reaction:

$$(O_2) + O + 2e^- \rightarrow O^{2-} + (O_2)$$



In case of contact of the gaugeable species with the cathode the impressed voltage between cathode and anode leads to a current. This is because the molecule or atom take electrons from the cathode and transport them to the anode.

The current can be measured and compared with diagrams, which were created for different partial pressures of the gaugeable species and different static pressures of the gas composition.

#### Difference between the oxygen sensors

The difference between the atomic and molecular oxygen sensor are the electrodes.

Atomic oxygen prefers reaction with gold electrodes however atomic and molecular oxygen prefers reaction with platinum electrodes.

So cermet electrodes on base of gold or platinum can allow a distinction between atomic and molecular oxygen.

The feedback control of the reduced potential with a reference electrode is very important because of the higher electrode polarisation in the gold electrode. The Sensor for O2 and O3 does not need this reference.

#### Ozone sensor

The ozone sensor works on another principle. But we must not tell more about it, because it is in a patent process.

#### **Summary**

The development of these precise sensors is an important step for better understanding of the complex and dynamic character of our atmosphere.

By means of this you can make precise prediction of specific gas densities, for example corrosive atomic oxygen.

That leads to a better assessment of necessary safeguards for long-term missions in the low earth orbit.

In addition we can better understand climatic effects which will lead to a better prediction of climatic changes and the weather.

#### 1.2 Mission Statement

We will test a new developed ozone sensor. In a review we will compare the measured data, in dependence on pressure (will be measured), with known data to estimate the sensors operation quality under conditions of the rocket flight.

Our secondary payloads are the sensors for atomic and molecular oxygen and a temperature sensor.



## 1.3 Experiment Objectives

#### Primary:

Obj. 1: Test of the ozone sensor during the flight.

Obj. 2: Measurement of atomic and molecular oxygen during the flight.

Obj. 3: Measurement of pressure (necessary for data analysis) during the flight.

### Secondary:

Obj. 4: Measurement of temperature during the flight.

## 1.4 Experiment Concept

Ozone, atomic and molecular oxygen, pressure and the temperature will be measured on the outer shape of our experiment module. So the module has to be modified in a way that the sensors (AO, O2, O3) look outside but are not directly in the airstream because the high velocity and pressure variations would disturb the measurements of the sensitive sensors. The sensor system is a balance between a good gas exchange in front of the sensors and the realization of an operation environment in which the sensors are able to work.

Two sensor boxes will be arranged in an angle of 180 degree and designed that the sensors are easy to exchange. Each sensor box will be controlled by a single electronic circuit. Each box is separated from the other to obtain two independent systems.

The sensor control provides a specific operating temperature for the sensors (AO about 600 °C,O2 about 550 °C,O3 about 120 °C).

The data will be collected and saved on a SD-card.

Some data will be send down to the ground station. That we have live measurement data of the flight.

All electronic circuits, the SD-card and rechargeable batteries will be stored and stabilized in boxes, which will be mounted on the bulkhead.



#### 1.5 Team Details

#### 1.5.1 Contact Point

Email: <u>contact@rexus-moxa.de</u>

Tel. Team leader: 015228981521

Website: <u>www.rexus-moxa.de</u>

#### 1.5.2 Team Members

Alexander Mager Team leader/ Payload

Aerospace engineer 6. Academic year

Bastian Klose Electronic & Software Design

Mechatronics engineer

6. Academic year

Patrick Geigengack Mechanics

Aerospace engineer 4. Academic year

Alexander Schultz Electronic & Software Design, Web

Mechatronics engineer

6. Academic year

Jonas Uhlman Mechanics

Mechanical engineer 6. Academic year

Daniel Becker Fluid mechanics

Aerospace engineer 4. Academic year

Fabienne Kinzelmann Outreach

Philosophies and Catholic Theology

3. Academic year

Susann Knapik Gas sensors

Chemical engineer 4. Academic year

Nathanael Warth Mechanics & Tests

Mechanical engineer
3. Academic year



Max Oswald Mechanics & Tests

Aerospace engineer 5. Academic year

Sebastian Weixler Mechanical engineer 3. Academic year Mechanics



### **2** EXPERIMENT REQUIREMENTS AND CONSTRAINTS

## 2.1 Functional Requirements

- F.1.: The experiment shall measure ozone on the outer shape of the RX rocket during the flight with two different electronic circuits.
- F.2.: The experiment shall measure atomic oxygen on the outer shape of the RX rocket during the flight with two different electronic circuits.
- F.3.: The experiment shall measure molecular oxygen on the outer shape of the RX during rocket the flight with two different electronic circuits.
- F.4.: The experiment shall measure pressure on the outer shape of the RX during rocket the flight with two different electronic circuits.
- F.5.: The experiment shall measure temperature on the outer shape of the RX during rocket the flight with two different electronic circuits.

## 2.2 Performance requirements

- P.1.: The ozone measurement (partial pressure) shall be made between  $10^{-6}$  bar and 1 bar.
- P.2.: The ozone measurement(partial pressure) shall be made with an accuracy of 2 % (between an attitude of 30 to 90 km).
- P.3.: The ozone measurement(partial pressure) shall be made with an rate of 100 measurements per second.
- P.4.: The atomic oxygen measurement(partial pressure) shall be made Between 10<sup>-6</sup> bar and 1 bar.
- P.5.: The atomic oxygen measurement(partial pressure) shall be made with an accuracy of 1 % (between an attitude of 30 to 90 km)
- P.6.: The atomic oxygen measurement(partial pressure) shall be made with an rate of 100 measurements per second.
- P.7.: The molecular oxygen measurement (partial pressure) shall be made between 10<sup>-6</sup> bar and 1 bar.
- P.8.: The molecular oxygen measurement(partial pressure) shall be made with an accuracy of 1% (between an attitude of 30 to 90 km)
- P.9.: The molecular oxygen measurement(partial pressure) shall be made with an rate of 100 measurements per second.
- P.10.: The pressure measurement shall be made between 10<sup>-4</sup> bar and 1.5 bar.



- P.11.: The pressure measurement shall be made with an accuracy of 8%.
  P.11: The pressure measurement from 20 mbar to 3 bar shall be made with an accuracy of 1.5 %.
- P.12.: The pressure measurement shall be made with an rate of 100 measurement per second.
- P.13.: The temperature measurement shall be made between -100 °C and 100 °C.
  - P.13.: The temperature measurement shall be possible between -100 °C and 200 °C.
- P.14.: The temperature measurement shall be made with an accuracy of  $\pm$ 1°C.
- P.15.: The temperature measurement shall be made with an rate of 100 measurement every second.
- P.16: The pressure measurement from 0.001 to 20 mbar shall be made with an accuracy of 10 %.
- P.17: The experiment shall save and process the data at a rate of 10 Hz.
- P.18: The experiment control loop shall process at 50 Hz.

## 2.3 Design Requirements

- D.1.: The experiment shall be designed to operate in the vibration profile of the RX rocket.
- D.2.: The experiment shall be designed in such a way that it shall not disturb and harm the RX rocket or other experiments.
- D.3.: The experiment batteries shall be qualified the rocket flights.
- D.4.: The experiment batteries shall be rechargeable to run the experiment during pre-flight test, flight preparation and flight.
- D.5.: The experiment batteries interface shall be accessible for recharging.
- D.6.: The experiment sensors shall be accessible for a late exchange.
- D.7.: The experiment sensors shall be put on the outer shape of the rocket for a convenient approaching flow.
- D.8.: The electronic boards has to be fixed and hedged against humidity and electromagnetic influences.
- D.9.: The hatch shall work (opening time, mechanism) under operating conditions.
- D.10.: The heat, produced by the electric, shall be dissipated.



## 2.4 Operational Requirements

- O.1.: The experiment shall operate automatically.
- O.2.: The experiment shall be release the hatch for the sensor protection automatically.
  - O.2.: The hatch shall be released automatically.
- O.3.: The experiment shall accept a request for radio silence at any time while on the launch pad.
- O.4.: The experiment shall store the measured data on a SD-card.
- O.5.: The experiment shall send a part of the measured data down to the ground station.
- O.6.: The experiment shall be able to turn off all electrical parts for landing.
- 0.7.: The experiment electrics shall control the sensors all the time.
- O.8.: The sensors must not be touched when they are hot.
- 0.9.: The automatic events shall automatically triggered by Timeline after liftoff.
- 0.10.: The manual events shall be transmitted over the REXUS Interface

#### 2.5 Constraints

- C.1.: The experiment shall fit in the module.
- C.2.: The experiment shall be able to handle the vibration spectrum.
- C.2.: The electric produces heat.
- C.4.: The flow vector on the experiment sensors change during the flight.



## 3 PROJECT PLANNING

## 3.1 Work Breakdown Structure (WBS)

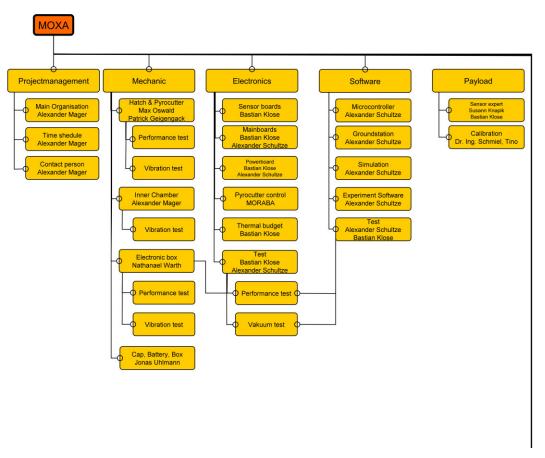


fig. 5: WBS (1)MOXA



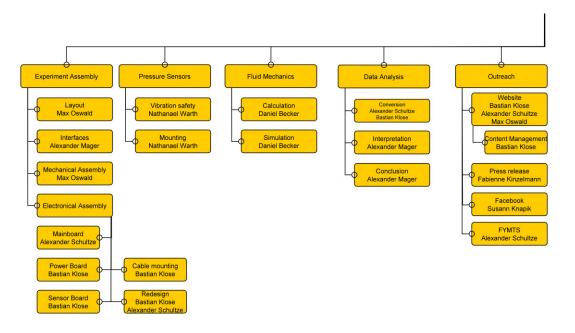


Fig. 6: WBS (2) MOXA



# 3.2 Schedule

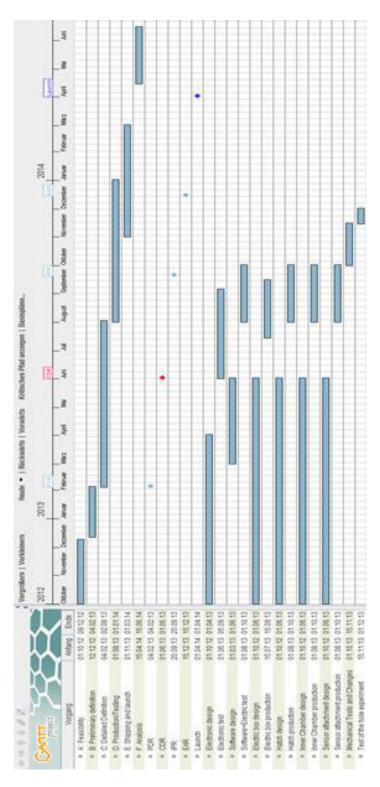


fig. 7: Timetable of MOXA experiment



#### 3.3 Resources

#### 3.3.1 Manpower

## Alexander Mager

- Aerospace engineer student
- Lectures of system engineering
- SOLID WORKS

#### **Bastian Klose**

- Mechatronics engineering student
- Specialization power electronics
- Practical training in micro controller programming

#### Alexander Schultze

- Mechatronics engineering student
- Specialization power electronics
- Board development in a student research project

## Patrick Geigengack

- Aerospace engineer student
- CATIA V5
- Dual studies of construction engineering (bachelor of science)

### Jonas Uhlmann

- Mechanical engineering student
- Designed a test stand in a student research project
- Traineeship in the area of designing mobile processing machine
- Student staff at Institute for Fluid Mechanics at TU Dresden
- SOLID WORKS, CATIA

#### **Daniel Becker**

- Aerospace engineer student
- Bachelor of engineering
- CATIA

#### Fabienne Kinzelmann

- Philosophies and catholic Theology
- Trained as a journalist



## Susann Knapik

- Chemical engineer student
- SOILD WORKS

#### Max Oswald

- Aerospace engineer student
- Internship at Astrium Satellites Friedrichshafen
- Student staff at Institute of Aerospace Engineering
- involved in the software development for the next student picosat of the TU Dresden (SOMP2)
- CATIA, SOLID WORKS

#### Nathanael Warth

- Aerospace engineer student
- SOLID WORKS

#### Sebastian Weixler

- Mechanical engineering student
- SOLID WORKS



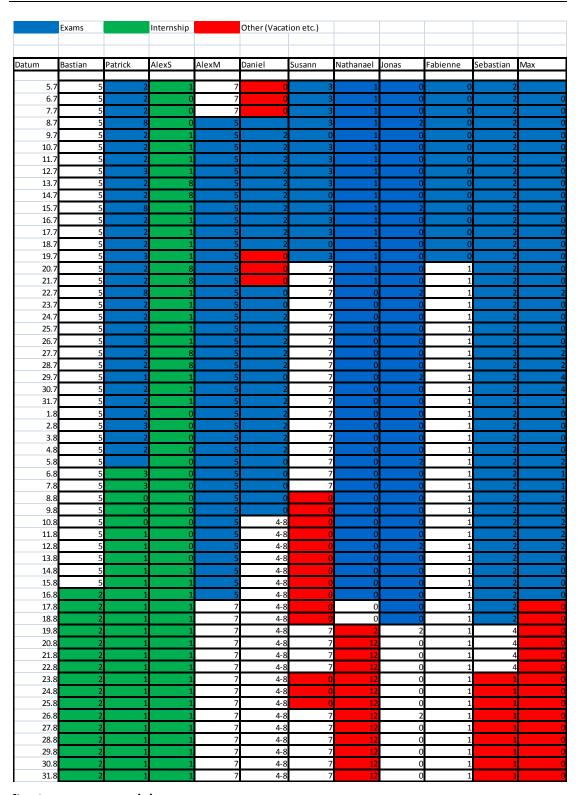


fig. 8: Manpower (1)



1.9	2	1	1	7	4-8	7	12	0	1	1	0
2.9	2	1	1	7	4-8	7	12	2	1	1	0
3.9	2	1	1	7	4-8	7	2	1	1	1	0
4.9	2	1	1	7	4-8	7	7	1	1	1	0
5.9	2	1	1	7	4-8	7	7	1	1	1	0
6.9	2	1	1	7	4-8	7	7	1	1	1	U
7.9	2	1	1	7	4-8	7	7	1	1	1	0
8.9	2	1	1	7	4-8	7	7	1	1	1	1.10
9.9	2	1	1	7	4-8	7	2	2	1	1	4-10
10.9	2	1	1	7 7	4-8	7	2	1	1	1	4-10
11.9	2 2	1 1	1	7	4-8 4-8	7 7	2	1	<u>1</u>	1	4-10
12.9 13.9	2	1	1	7	4-8	7	2	1	1	1	4-10 4-10
14.9	2	1	1	7	4-8	7	7	1	1	1	4-10 4-10
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16.9	2	1	1	7	4-8	7	7	2		1	4-10
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2.10	2	1	0	7	0	7	2	1	1	4	4-10
3.10	2	1	0	7	0	7	2	1	1	4	4-10
4.10	2	1	0	7	0	7	2	1	1	4	4-10
5.10	2	1	0	7	0	7	2	1	1	4	4-10
6.10	2	1	0	7	0	7	2	1	1	4	4-10
7.10	2	1	8	7	0	7	2	1	1	4	4-10
8.10	2	1	8	7	0	7	2	1	1	4	4-10
9.10	2	1	8	7	0	7	2	1	1	4	4-10
10.10	2	1	8	7	0	7	2	1	1	4	4-10
11.10	2	1	8	7	0	7	2	1	1	4	4-10
12.10	2	1	8	7	0	7	2	1	1	4	4-10
13.10	2	1	0	7	0	7	2	1	1	4	4-10
14.10	2	1	0	7	0	7	2	1	1	4	4-10
15.10	2	1	1	7	0	7	2	1	1	4	4-10
16.10	2	1	1	7	0	7	2	1	1	4	4-10
17.10	2	1	1	7	0	7	2	1	1	4	4-10
18.10	2	1	1	7	0	7	2	1	1	4	4-10
19.10	۷.	1	1	7	0	7	2	1	1	4	4-10
20.10	2	1	1	7	0	7	2	1	1	4	4-10
21.10	2	1	1	7	0	7	2	1	1	4	4-10
22.10	2	1	1	7	0	7	2	1	1	4	
23.10	2	1	0	7	0	7	2	1	1	4	
24.10	2	1	0	7	0	7	2	1	1		
25.10	2	1	0	7	0	7	2	1	1	4	
26.10	2	1	0	7	0	7	2	1	1		
27.10	2	1	0	7	0	7	2	1	1	4	4-10
28.10	2	1	0	7	0	7	2	1	1	4	4-10
29.10	2 2	1 1	0	7 7	0	7 7	2	1	1 1	4	4-10
30.10	2	1	0	7	0	7	2	1		4	
31.10	2	1	Ü	/	0	7	2	1	1	4	4-10

fig. 9: Manpower (2)



Week	Bastian	Patrick	AlexS	AlexM	Daniel	Susann	Nathanael	Jonas	Fabienne	Sebastian	Max
4			10	10	1		2 5	2	-,-		
4.				10	1		2 5	2	-,-	10	15
4			10	10	1		2 5	2	0,5		
4			10	10	1		2 5	2	0,5		
4			- 10	10			2 5	2	0,5		
4:			10	10	1		2 5	2	. 0,3		
5			10	10	1		2 5	2	0,5		
5			. 0	10	1		2 5	2	0,5		
5.			. 0	10	1		3 5	2	0,5	10	10
2014	1 5	1	. 5	10	1	3	3 5	2	0,5		
:	2 5	1	. 5	10	1		3 5	2	0,5	10	15
:	3	1	5	10	1	3	3 5	2	0,5	10	15
	4 5	1	. 5	10	1		3 5	2	0,5	10	15
!	5 5	1	. 5	10	1		3 5	2	0,5	10	10
	6	1	. 5	10	1		3 5	2	0,5	10	5
	7 5	1	5	10	1		3 5	2	0,5	10	5
	5	1	5	10	1		3 5	2	0,5	10	5
	9 5	1	. 5	10	1		3 5	2	0,5	10	5
1	5	1	. 5	10	1		3 5	2	0,5	10	5
1	1 5	1	5	10	1	***	3 5	C	0,5	10	5
1	2 5	1	. 5	10	1		3 5	C	0,5	10	5
1	3 40	1	41	10	1		3 5	C	0,5	10	20
1	40	1	41	10	1		3 5	C	0,5	10	20
1	5	1	. 5	10	1		3 5	C	0,5	10	20
1	5 5	1	. 5	10	1		3 5	C	0,5	10	20
1	7 5	1	. 5	10	1		3 5	C	0,5	10	20
1	3 5	1	5	10	1		3 5	C	0,5	10	20
1	9 5	1	. 5	10	1		3 5	C	0,5	10	20
2	) (	1	0	10	1		3 5	0	0,5	10	20
2	1 (	1	0	10	1		3 5	C	0,5	10	20
2	2 (	1	0	10	1		3 5	C	0.5	10	20

fig. 10: Manpower (3)



## 3.3.2 Budget

The fabrication of the mechanic will be taken by our university.

Table 3-1: Mechanical and Electric Parts Cost Estimate

ip. C. ▼		50 €																								
▼ Ordered ▼ Total Amount ▼ Sponsor ▼ Cost for DLR ▼ other sp. C.	148,02 €	9 0	300€	148,02 €	257 €	71,40 €	0€	30€	90€	49,00 €	481 €	320 €	43,37 €	16,85 €	139,70 €	140,62 €	90€	109,02 €	30€	9 0	86,31 €	3 0	73,93 €	675,92 €	170,37 €	0 00 000 0
Sponsor 🔻	DLR	Bastian K	DLR	DLR	DLR	DLR	Other	TUD	TUD	DLR	DLR	DLR	DLR	DLR	DLR	DLR	TUD	DLR	TUD	TUD	DLR	TUD	DLR	DLR	DLR	
Total Amount	3	2		3		1	80		6	2		2														
Ordered 🔻	2	2		2		0	0		6	2		0			1	1	1	1	П	1	1	1	1	1	1	
▼ Subsection	Mainboard PCB	Protoboards	Mainboard Parts	Sensorboard PCB	Sensorboard Parts	Powerboard	Temperature PCB	Generic	Sensors	Magnetic Switch PCB	Generic Parts	PCB for Sensors	Magnetic Switch Parts	RXIF SIM	Screws	Chemicals	Hatch in-house production	Hatch purchase parts	Inner Chamber in-house production	Electronic Box in-house production	Electronic Box purchase parts	Modul in-house production	Modul purchase parts	Pirani Sensor	Piezo Sensor	
	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Electronic	Mechanic	Mechanic	Mechanic	Mechanic	Mechanic	Mechanic	Mechanic	Mechanic	Mechanic	Mechanic	Mechanic	
Number V Section	1	2	က	4	2	9	7	<b>∞</b>	6	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	



#### 3.3.3 External Support

## **Dresden University of Technology**

Institute of Aerospace Engineering Space Systems

Prof. Dr. Martin Tajmar

- Dr. Tino Schmiel (Head of research group of the sensor development (AO,O2,O3))
- Dr. Christian Meyer (responsible for the ozone sensor)

### Chair of Fluid Dynamics

Dr. Frank Rüdiger (Shallow water analogy)

## 3.4 Outreach Approach

#### 3.4.1 Social Media



fig. 11: Facebook, site

In January 2013, we launched a *Facebook page* to inform industry insiders, journalists, classmates and friends about our project's progress and other news. <a href="https://www.facebook.com/REXUS.MOXA">www.facebook.com/REXUS.MOXA</a>



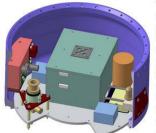
#### 3.4.2 Website





#### Overview of our Experiment

The models of the distribution of residual gases in the atmosphere vary widely, for instance the atomic oxygen models provide results differing up to 400%. To predict climate it is important to know the distribution of oxygen in its forms molecular and atomic oxygen as well as ozone more accurately. Also, atomic oxygen has a major influence on space borne objects, as it degradates exposed materials aggressively.



Therefore the MOXA experiment will measure ozone, atomic and molecular oxygen partial pressure, temperature and pressure during the flight. The Institute for Aerospace Engineering at TU Dresden has developed innovative sensors for oxygen and ozone with a very low response time and high measurement accuracy. The atomic oxygen sensors of the FIPEX experiment already performed successful measurements onboard the International Space Station and will be integrated in our experiment in a new, miniaturized form.

The currently developed ozone sensor will be tested by comparing data collected during flight with existing data. In

addition, the data of the oxygen measurements can give a hint on the ozone values and will help to verify the functionality of the ozone sensor.

The development of precise sensors for residual gases contributes to the more detailed investigation of the atmosphere. It is crucial to correlate existing, partially contradictive, atmospheric models with new, more extensive data to create a new model which allows a more precise prediction of the distribution of residual gases. This will support atmospheric science and improve the preparation potential of material etc. for long term low earth orbit

fig. 12: Website

Our website can currently be visited via <a href="www.REXUS-MOXA.de">www.REXUS-MOXA.de</a>. The website generally informs about the REXUS program, our MOXA team and of course about our experiment. Furthermore, we there collect and present all published articles and posts about MOXA. In future, every visitor of the website will have access to press material (press releases, photos, etc.).



#### 3.4.3 Classic PR-work



#### fig. 13: MOXA on TU Dresden

On the 8<sup>th</sup> of January, the TU Dresden's press office sent out our first *press release* under the heading "Studenten der TU Dresden starten ein weiteres Weltraumprojekt" (http://tu-dresden.de/aktuelles/newsarchiv/2013/1/REXUS). About ten magazines and papers took it out in either print or online. Moreover, we published a detailed article in our University's Journal. This article appeared on the front page on the 14<sup>th</sup> of January (PDF: <a href="http://bit.ly/Y1A8Bv">http://bit.ly/Y1A8Bv</a>). Throughout the very first press release and the article, we gained a lot of attention. Several media wanted to report about us and our project. We were already interviewed by different media, for example by the Campusradio Dresden and the MDR (Mitteldeutscher Rundfunk).

#### 3.4.4 Flyers, Posters, Buttons

So far, we have already designed flyers, posters and buttons which present our work in courses or on special events on university.

#### 3.4.5 Fly Your Message To Space (FYMTS)

Our campaign "Fly Your Message To Space" (FYMTS) will give people the chance to send a small message to outer space. These messages will be collected and printed out, being included inside the MOXA experiment box, each on a further sheet of paper. We would like to use the campaign to get more attention for the rocket start about two months in advance. We are quite sure that the press would love the idea to report about FYMTS and will also spread the call out for messages.



# 3.5 Risk Register

## Table 3-2: Risk Register

ID	Risk(& consequence if not obvious)	Р	S	PxS	Action
M-X-01	Parts get unconnected due to vibration	В	3	Low	Vibration test
M-X-02	Hatch is not opening	С	3	Low	Function test
M-X-03	Hatch is closing uncontrolled because of malfunction of the springs	С	3	Low	Function test
M-X-04	Hatch is opening to early	Α	2	Very low	Test
M-X-05	Hatch tilts on the guide	Α	3	Very low	Test and good design of tolerances
M-X-06	Pyrocutter doesn't fire	Α	3	Very Low	Calculation and test
M-X-07	Springs crack	Α	2	Very low	Test and consultation with manufacture for probability
M-X-08	Sensor breaks	В	3	Low	Sensors are intermountable
M-X-09	Hatch or inner chamber not tight (hot air gets in the module)	Α	3	Very low	Good design
M-X-10	Anything gets damages during late access	Α	2	Very low	Plan of procedure
M-X-11	Air inlet or outlet gets unconnected during flight	Α	5	Low	Redundancy of screws
M-X-12	Cables break/get unconnected	Α	3	Very low	Design large bend radii
M-X-13	Flexible tubes breaks / get unconnected	Α	3	Very low	Design large bend radii
M-X-13	Pyrocutter fires to early	Α	2	Very low	Controlled by MORABA
E-X-01	Mosfet gets overheated during the flight	В	4	Low	Vacuum chamber test
E-X-02	DC/DC Converter gets overheated during the flight	В	4	Low	Thermal design and Vacuum chamber test



E-X-03	Battery gets overheated	С	3	Low	Calculate and test before CDR
E-X-04	Short circuit	Α	4	Very low	Function Test
E-X-05	Connectors do not complete the circuit while flight	A	3	Very low	Select connectors that are resistant to vibration
P-X-01	Team member leaves the project	Α	4	Very low	Allocate responsibilities
P-X-02	Team member is temporary not available for personal reason	В	3	Low	Use flow chart and time schedule
P-X-03	Conflicts in the team slow the work flow.	В	2	Very low	Communication, Share tasks in work packages
P-X-04	Team member underestimates the amount of work	С	2	Low	Time schedule
P-X-05	Have not as much people as required working on the project	В	3	Low	Time schedule
L-X-01	Material on Order arrives too late	С	2	Low	Schedule buffer time
L-X-02	Parts ordered too late	Α	3	Very low	Adhere strictly to the time schedule
L-X-03	Material on order are broken or don't fit	В	3	Low	Schedule buffer time
F-X-01	Delayed Fabrication of the university workshop	В	3	Low	Schedule buffer time
F-X-02	Detect design failure during the fabrication	В	4	Low	Schedule buffer time
F-X-03	Bad communication and misunderstandings between the team and the workshop	A	2	Very low	Appoint a contact person
S-X-01	Experiment Software Synchronization Loss (LO)	Α	2	Very low	Synchronize Data after Landing
S-X-02	SD Card Failure	Α	1	Very low	Redundancy: RX I/F
S-X-03	RX I/F Failure	Α	1	Very low	Redundancy: SD Card



S-X-04	Experiment Restart during Flight (Power Line Cut, Experiment Stuck)	Α	2	Very low	Instantly start collecting data
S-X-05	Critical Module Failure (DAC, ADC, Quartz)	Α	3	Very low	Extensive Preflight Tests
S-XXX	Software is not Ready at Launch	Α	3	Very low	Time schedule

E.....Electronics

M....Mechanics

P.....Personal

L.....Logistic

F.....Fabrication

S.....Software



#### 4 EXPERIMENT DESCRIPTION

Due to the interesting higher concentrations of atomic oxygen above 70 km and for Ozone between about 10-50 km, we need to provide adequate measuring during the complete REXUS flight. To provide best measurements during high and low atmospheric pressure two different kinds of measurement chambers will be used. One set of sensors will be placed within an inner chamber. The chamber is designed for high velocity and high pressures. The outside chamber is protected by a hatch. After the hatch opens the sensors will be directly exposed and will therefore perform measurements of low pressure slows down airspeed.

The hatch will be triggered by MORABA after the burnout of the rocket engine at around 30 km (28 seconds) and expose the outside sensors during the apogee of the flight. Additional pressure and temperature sensors are included to each module.

**Table 4-1: Experiment Timeline** 

ToF [s]	-1000	-900	-100	0	28	50	100	150	200	250	300	350
Height[km]	0	0	0	0	30	40	70	90	70	30	12	5
Heating												
Measurement												
Valid Range												
(AO)												
Valid Range												
(02)												
Valid Range												
(O3)												
Hatch					Х							
Shutdown												Χ

The sensors will be exchanged at the beginning of the campaign in Kiruna to ensure their functionality. At launchpad the Sensors will be preheated to their operating temperature. Measurements will be performed after liftoff and the hatch will be opened at about 30 km height by timeline. At shutdown, all the sensors will be disabled and the experiment will be switched off.

## 4.1 Experiment Setup

The system design will be described using SART (acc. Hatley87). The experiment system design implements two similar independent designs.



## 4.1.1 System Model

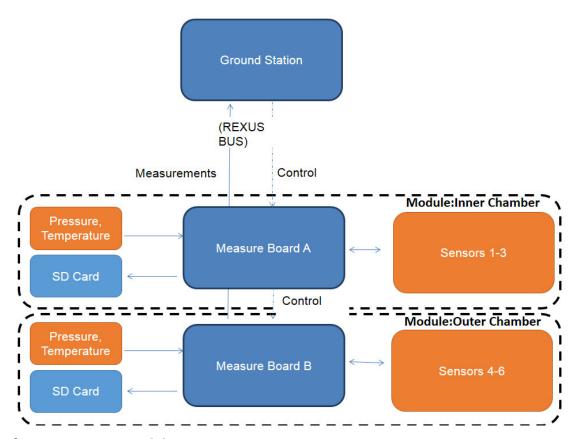


fig. 14: System Model

**Table 4-2: Module Specifications** 

Device	Hardware	Software	Function
Measurement Board A	STM32F1 ARM7		Measurement, Saving, Transmission
Measurement Board B	STM32F1 ARM7		Measurement, Saving
REXUS BUS	RS422		Data Transmission
Ground Station	x86 PC	Java, Windows or Linux	Data Receiving and Saving



## 4.1.2 Modules

The MOXA experiment electronics will be designed modular. The two modules (similar structure) will be stand-alone. They will be developed on standardized 4-layer Euro-size circuit boards.

An additional circuit board will be designed for the power system. All systems will be housed in (Electro Magnetic Capability (EMC) shielded segments of the box to avoid EMC troubles.

Table 4-3: Data lexicon

Data Flow	Description
Control	Bit LO, Bit SOE
Temperature	0-600°C
Temperature (analog)	3-11 Ohms
Reference Measurement Value	300 mVolt
Reference Heating Value	0-3.3 Volt
Measurement I	0-3.3 Volt
Measurement U	0-3.3 Volt
Heating I	0-3.3 Volt
Heating U	0-3.3 Volt



# 4.2 Experiment Interfaces

#### 4.2.1 Mechanical

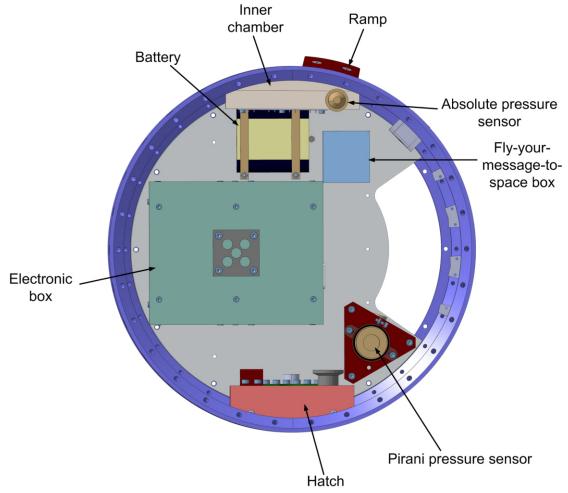


fig. 15: Top view of experimental module

The bulkhead is mounted with 11x EN ISO 4762 M5x12.

- The hatch will be mounted with 4x EN ISO 7046-1 M5 screws, from outside.
- The inner chamber is split into parts inside and the ramp outside. The ramp will be mounted on the outer shape of the module with 4xDIN965 M4 counter-sunk screws. The inside parts, mounted together with screws, will be attached with the adhesive OMEGA Bond 300 which provides an safety of 272. Additional it will be mounted with one M4 counter-sunk screw.
- There will be a thread in a drill hole at the inner chamber to mount the piezo pressure sensor.
- The Pirani sensor will be mounted with a screwed clip on top of an aluminium plate which is connected to the bulkhead via tree screws, three vibration



dampers and tree spacers. There are several configurations for the rubber dampers. A final setting was chosen after the vibration tests.

- The electronic box will be mounted with 6xDIN 912 M4 screws on the bulkhead.
- The fly-your-message-to-space box will be mounted with 2x DIN 912 M3 screws on the bulkhead.
- The battery will be pinched with two plates that will be fixed with two M3 nuts on threaded rods.

There is no modification concerning the mounting of the D-Sub-bracket or the attachment of the module with the experiments below and above.

All screws will be locked with Loctite at the final assembly. Where we have enough space there will be serrated lock washers or rather screws with tooth head.



# 4.3 **Experiment Components**

Mechanical parts and connectors are listed in this section. All electronic components that have to be soldered on one of the PCB Boards are listed in appendix C.

# 4.3.1 Mechanical Parts

**Table 4-4: Mechanical Parts summary table** 

component	supplier ▼	current status	weight in Kg
			0.50
Srews and little fixation parts	several	ordered	0,50
Hatch			
parts of in-house production (material:AIMgSi1)	TUD	ordered	0,90
springs	GUTEKUNST	ordered	0,01
photosensor	CONRAD	ordered	0,03
slide bushes	IGUS	ordered	0,01
shafts	MISUMI	ordered	0,01
pyrocutter	TRW	ordered	0,02
Inner Chamber			
Ramp (material: X5CrNi18-10)	TUD	ordered	0,25
inside parts (material:AlMgSi1)	TUD	ordered	0,60
high temperature adhesive	OMEGA	ordered	0,01
Electronic box			
parts of in-house production (material:AlMgSi1)	TUD	ordered	1,10
other	several	ordered	0,20
			Í
Module			
pirani sensor	PCE	ordered	0,12
pirani flexible tube	LANDEFELD	ordered	0,01
pirani vibration dumper	Schwingungsdämpfer DD	ordered	0,01
piezo sensor	sensor technics	ordered	0,10
battery	FEYELECTRONIK	ordered	0,14
box (Fly your message to space)	CONRAD	ordered	0,02
5 , ,			,
		Total mass mechanic	4,04



Table 4-5: Experiment summary table

Attribute	Dimension
Experiment mass (in kg):	8.973kg including module and bulkhead
Experiment dimensions (in m):	Ø 0.348 x 0.130
Experiment footprint area (in m <sup>2</sup> ):	0.0657
Experiment volume (in m <sup>3</sup> ):	0.012
Experiment expected CoG (centre of gravity) position:	(x=137, y=106, z=0.191)

# 4.4 Mechanical Design

#### 4.4.1 Outer structure

We use a 170 mm module that is provided by the DLR together with the bottom mounted bulkhead. The bulkhead will be modified with holes for screws to mount the board box and all parts that are located at the bottom of the module.

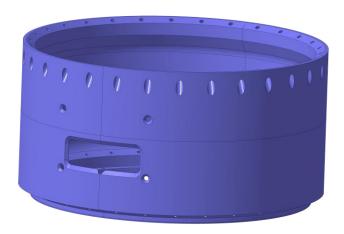


fig. 16: Outer casing

There are some modifications concerning the module. To allow the sensors access to the environmental air, 3 recesses will be made. One is situated at 270° from the 0° line with the dimensions 95mm (length) and 30mm (height). This one gives the sensors in the hatch (see 4.4.3) access to the ambient air. As shown in the description of the hatch this hole will be closed at the launch and opened during flight.

The other two recesses are situated opposite of the one at circa 90°. They will give the other sensors that are situated in an inner chamber access to the ambient air. These are just small drill holes with a diameter of 2.54mm. Below the D-Sub bracket at 180° will be a pass in the bulkhead for any cables between the modules. The dimensions are shown in the picture below.



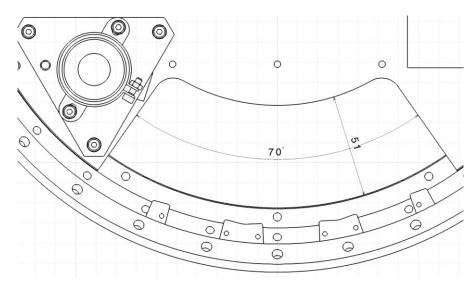


fig. 17: pass for cables

# 4.4.2 Board box

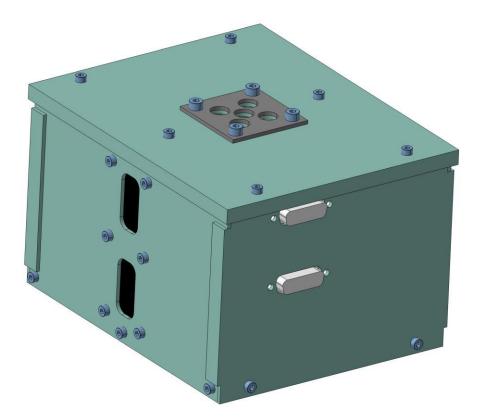


fig. 18: board box



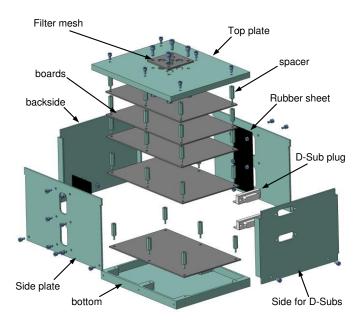


fig. 19: board box (exploded view)

The board box is the centre of the module. It includes two mainboards, two sensorboards and the powerboard.

Array of the boards from top to bottom: mainboard – senorboard – mainboard – sensorboard – powerboard

The board box consists of one bottom plate, one front plate, one backside plate, two identical side plates and one top plate. The powerboard is directly mounted onto the bottom plate, the following boards are mounted and fixed on each top of another with 17mm spacers. The front plate has two cut-outs for the two D-sub-interfaces. In the middle of the two side plates are two cut-outs for the wires to the sensorboards and the powerboard. The front and backside plates are fixed on the bottom plate with self-sealing 2x EN ISO 10642 - M3x8, the two side plates are fixed with self-sealing 3x EN ISO 10642 - M3x8. The top plate is fixed with 6x EN ISO 10642 - M3x8 directly with the spacers from the upper mainboard. Front-, backside and side plates are form-closed by the top plate, and in addition the side plates get stabilization by flaps of the front- and backside plate.

The board box is not designed to be gastight. It is just designed to cover the boards and to prevent the income of small aluminium chips. Air flow will be enabled through five holes (diameter 10mm). These holes are covered with a 45x45mm filter net to prevent the boards from aluminium chips and thereby eventually caused short circuit. The net is fixed between a small 45x45mm plate (also with 5x 10mm holes to enable air flow), the plate is fixed on the top plate with 4xM4 screws and nuts. The whole board box is affixed on the module with 6x EN ISO 10642 – M4x12. All plates will be manufactured of aluminium (EN AW-6082 T6).



#### 4.4.3 Sensors box with hatch

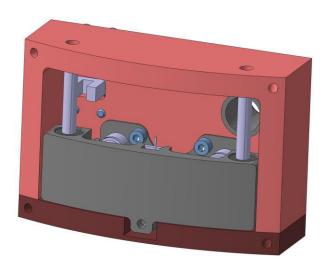


fig. 20: hatch assembly

This is one of two assemblies which include sensors, the other one is the inner chamber in chapter 4.4.4. The included sensors will measure atomic oxygen, molecular oxygen, ozone and temperature, so there are 4 sensors inside.

The main task of the hatch is to mount the sensors in the module and give them access to the ambient air by demand. The sensors will be protected from exhaust gases at the launch. That will be realized by a hatch plate that is closed and fixed by thin steel wire in the initial position. This wire is clamped with a plate and 4 screws on the movable hatch and again with a clamping plate and 4 screws on the underneath bottom plate of the hatch housing. By cutting the thin wire with a pyrotechnical cutting cylinder we open the hatch with springs that push the hatch up. In the pictures below you see schematics of this mechanism.

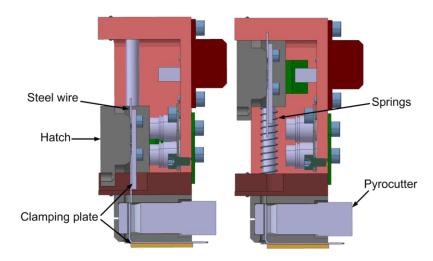


fig. 21: hatch function



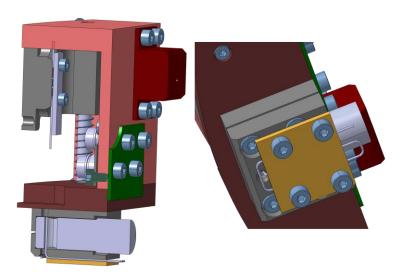


fig. 22: Detail view clamping mechanism

# Part overview of the hatch mechanism

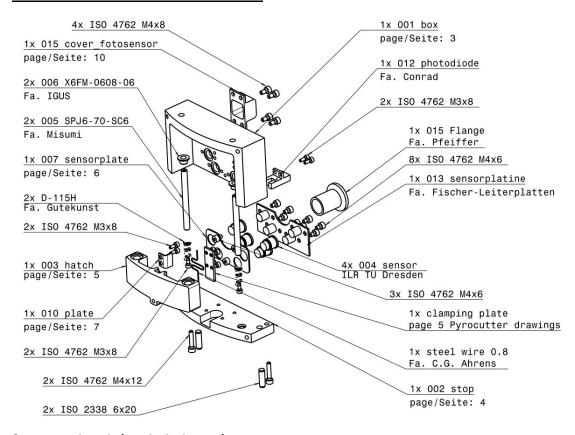


fig. 23: hatch (exploded view)

Materials for each component are shown in the attached drawings.



# box and sensor mounting

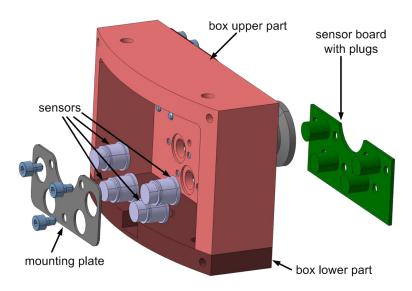


fig. 24: sensor mounting hatch

The outer box is made of two parts that are assembled with screws 2 x EN ISO 4762 M5x15 and positioned with bolts 2 x EN ISO 8734 6x15 to realize an accurate mounting on the module wall.

The four sensors are positioned in four cuts in the upper part. On the backside of the box there is a sensor board with four plugs mounted (8 x EN ISO 2010 2x6). The sensors are attached to these plugs. To prevent an unplugging of the sensors we mounted them with a plate from the other side that pushes them with its 3 x EN ISO 2010 M3x6 screws against the box so that a form fit is realized (the holes in the plate are smaller than the smallest sensors diameter).



### hatch mechanism

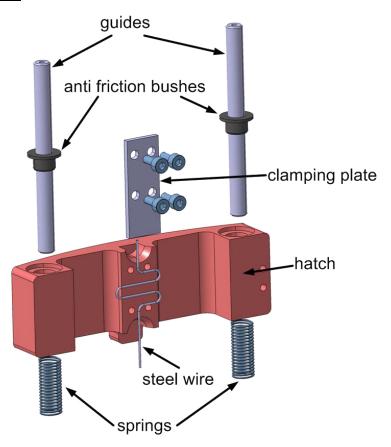


fig. 25: Hatch mechanism

To move the hatch there are four antifriction bushes integrated in the aluminium plate. They touch the guides which will support a fluent movement of the hatch. The springs push the hatch up when the wire is cut.

While beeing stressed the springs each have one a force of 16.38 N. So a force of 32.76 N pushes the hatch to open the recess in the module completely so that air can get to the sensors.

The steel wire which keeps the hatch in its inital position is cut at an altitude of around 30 km by a pyrocutter. It is fired by an electric current of at least more than 0.4 A. To fire it in any case there have to be a current of 1.2 A. The triggerring of the explosive inside the pyrocutter lies by MORABA(Mobile Raketen Basis, DLR).

The replacement of the pyrocutter and the wire due to tests requires an unscrewing of the hatch box out of the module and a disintegration of the clamping plates and the pyrocutter mounting.



Owing to the fact that the pyrocutter contains explosives there have to be some security constraints. To prevent early ignition and damage to men or material the electric circuit have to be capsuled and seperated from other cords.

# **Positioning photo sensors**

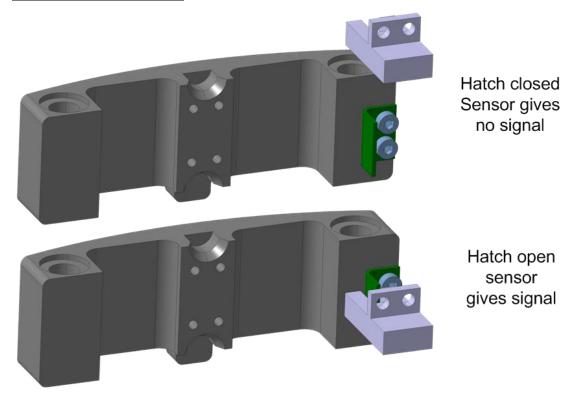
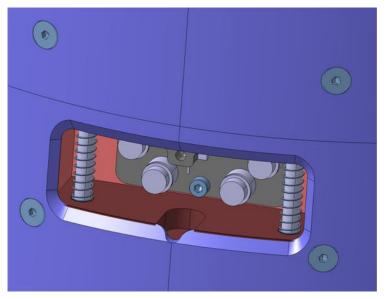


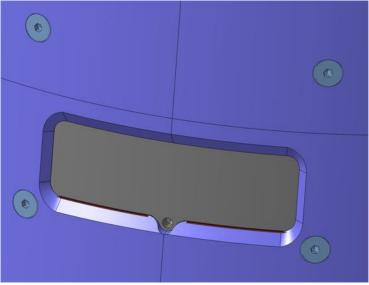
fig. 26 photo sensors

To know whether the hatch is closed or open we use a photo sensor (mounted with  $2 \times EN$  ISO 4762 M3 x 6) and a cover mounted on the hatch with  $2 \times EN$  ISO 2010 2x6. The cover will move between the light beam of the sensor when it is opened so we get a feedback of the position of the hatch.





open state



closed state

fig. 27 open and closed hatch



### 4.4.4 Inner chamber

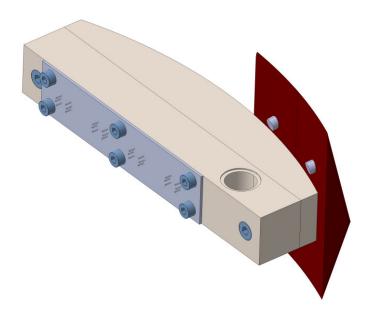


fig. 28 inner chamber

The principal task of the inner chamber is to offset air of the fluid flow streaming on the rocket. This requires that the inlet geometry wont heat up too much, the inlet should not disturb the aerodynamic of the rocket and the gas exchange should be very fast without stressing the gas sensors to much.

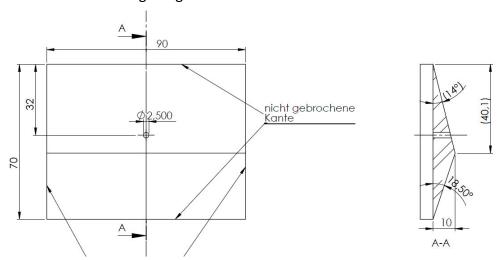


fig. 29 ramp

Because the ramp is very flat the fluid flow has little contact points for friction, so the ramp wont heat up so much. Also because the ramp is so flat, it has little contact area for the fluid flow to disturb it.



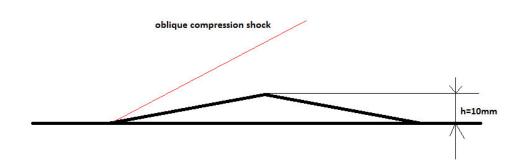


fig. 30 compression shock

The break for the fluid flow, caused by the ramp, leads to an oblique compression shock. Across this shock the pressure, temperature and airflow velocity change. The velocity will go down and the temperature rises, but the most important fact is that the pressure rises too. So the pressure at the ramp is higher than the pressure next to the ramp.

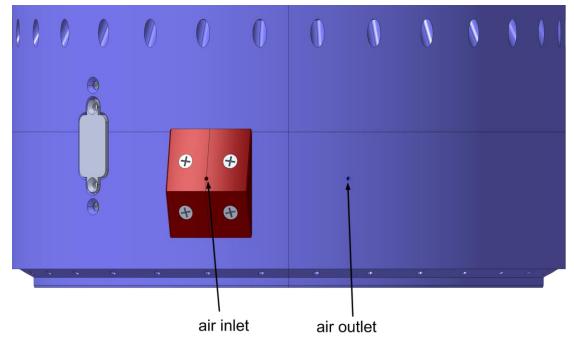


fig. 31 Ramp on module with air in- and outlet



Between the drill holes of the in- and outlet the air flow generates a pressure differential which leads to an air flow through a chamber with sensors for pressure, temperature, ozone, atomic and molecular oxygen.

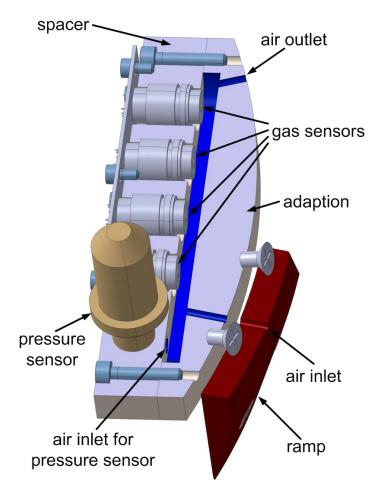


fig. 32 air stream through inner chamber

After the air flows through the inlet in the chamber it hits the spacer, scatters there and expands because of the profile extension. Because of the pressure differential the air flows over the sensors to the outlet and leaves the inner chamber.

The ramp, made of X5CrNi18-10 will be mounted with 4 x DIN965 M4 counter-sunk screws. The adaption which is made of AlMgSi1 will be glued from the inside on the shape with a safety of 272 and positioned with one DIN 7991 M4 counter-sunk screw. Then the spacer is fixed with two M4 screws on the adaption. The sensor board, with the soldered sensor clips, is fixed with six M3 screws. The sensor board is easy to disintegrate for an easy exchange of the sensors.



#### 4.4.5 Pressure sensors

To measure the pressure we use the following sensors in the named subassemblies (more information in the datasheets):

Hatch sensor box : VSP63

Internal sensor box : Keller-21Y

The VSP63 sensor will not be mounted directly where the measurement is taken because of space problems. We use a flexible tube to connect the sensor with the position of measurement. To mount the flexible tube at the hatch and at the sensor we will be using hose band clips over a screwable adapter. The flexible tube will have an inner diameter of 9 mm. The sensors themselves have suitable connectors.

The VSP63 pressure sensor will be fixed as shown below.

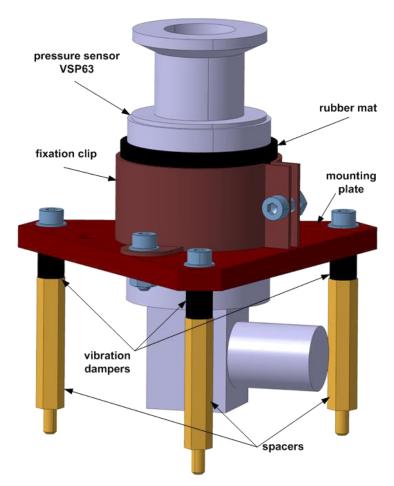


fig. 33 sensor fixation



The sensor will be fixed by a clip which will be screwed down. A rubber mat will be placed between the sensor and the clip to prevent damage to the sensor. The clip will be held by two screws which connect the clip with the mounting plate. The plate will be mounted on three vibration dampers. These will decouple the sensor from vibrations. The dampers will be installed on top of the spacers to create enough place for the electric connector. The spacers will be screwed directly on the bulkhead. Detailed information about the dimensions will be found in the drawings.

# 4.4.6 Position and fixation of the Battery

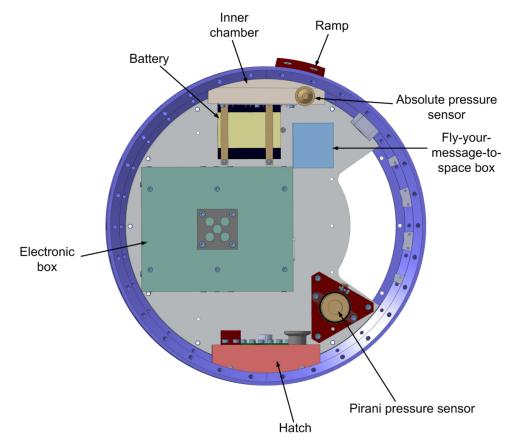


fig. 34 top view of the experiment

The picture above shows the position of the battery. It will be fixed by two screwed metal strips at the bulkhead.

## 4.4.7 "fly your message to space"- part

The messages that will fly to space will be printed on two or three sheets of paper. These sheets will be inside a closed box with an venting hole, so its not air tight. To ensure that the paper will not block the hole, we will push it down with a screw and clip them together. The box will be mounted by two screws in the bulkhead.



#### 4.5 Fluid Mechanic

For the implementation of measuring ozone, atomic oxygen and molecular oxygen we choose two experiments for different height ranges. For ranges higher than 30 km, we use a cavity which opens its hatch a few seconds after lift-off and reveals the sensors. Because of decreasing density and the high velocity of the rocket we use an inner chamber for representative measurements up to an altitude of 30 km.

To analyze the flow over the cavity of our module, we build a simple 2d-model (fig. 35) with the assistance of simulation software to work with it. Problems in this experiment might be the turbulent flow around the sensors, placed at the bottom of the cavity, and the conditions of the air properties in the higher altitude, e.g. low density. On the basis of these facts we agree to a supplementary configuration for ozone-measurement in lower altitude, up to. 30 km.

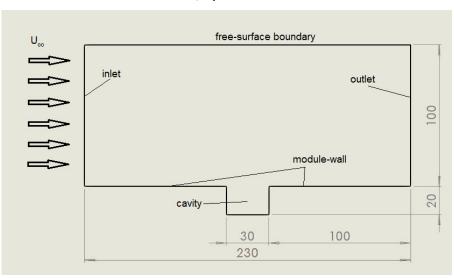


fig. 35: 2d-Scheme of the 2d-model of the MOXA-module

For first simulations of the fluid models we use simple dates for incompressible fluids to show the functionality of our experiment in a simple ambience. We want to consider the flow dynamics with different settings in stationary vicinity at determined altitudes. The series of tests will start with constant density and low speed. In additional tests the speed approach up to the flight speed of the rocket, the density is still constant. After the test with increasing speed of the incident flow, we want to realize additional tests with changing density. The velocity profile (fig. 36) is adopted by the experiments of Spalart "Direct simulation of a turbulent boundary layer up to  $R\theta = 1410$ " from 1998.



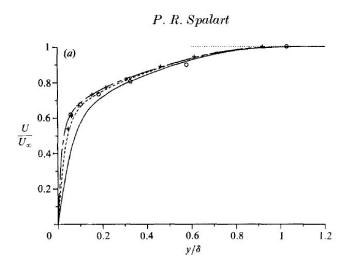


fig. 36: Velocity profile at different Reynolds numbers by the Experiment of Spalart "Direct simulation of a turbulent boundary layer up to R $\theta$  = 1410" from 1998

The calculations of the issues occur with the Shear Stress Transport Modell (SST) and most likely with the Reynolds Stress model (RSM). Here, the SST-Model requires much less computation time as the RSM and combines the advantage of the k- $\omega$ -model near the module boundary with the advantage of the k- $\omega$ -model for the free-surface boundary. The RSM owns higher model accuracy but with the disadvantage of higher effort and no guarantee of more precise results. The outcome of the SST-Model is acceptable, so the RSM is not really necessary.



# 4.6 Electronics Design

### 4.6.1 Microcontroller Design (Mainboard PCB)

To handle measuring and data handling, for each sensor control board one ARM7 microcontroller of the type STM32F103RB will be used. A customized PCB with supplementary ADC, DAC, SD-Card and USART level converters with be used.

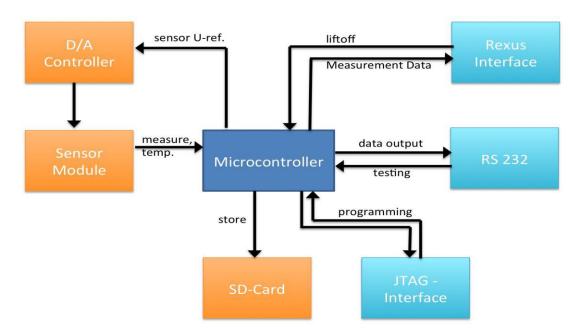


fig. 37: Simple schema of our microcontroller architecture

For better understanding all modules are explained in this chapter. Very important modules are listed with a connection-table for detailed information. All other modules are connected as recommended in the data sheet. You can find the pdf document for circuits and board layout as well as the part lists with a hyperlink to the distributor in Annex C.

### Microcontroller:

Our main unit. Pin connections are described here:

**Table 4-6: Connections** 

PIN	Function MOXA	Signal	Туре
PA0	ADC	ADC1\$1	A/D sensor 1
PA1	ADC	ADC1\$2	A/D sensor 1
PA2	ADC	ADC1\$3	A/D sensor 1
PA3	ADC	ADC1\$4	A/D sensor 1
PA4	SPI (DA, AD)	NSS D/A	external DAC and ADC



PA5	SPI (DA, AD)	SCK D/A	external DAC and ADC
PA6	SPI (DA, AD)	MISO	external DAC and ADC
PA7	SPI (DA, AD)	MOSI	external DAC and ADC
PA8	Measure I/O	CS_DAC	Chip Select DAC
PA9	Measure I/O	CS_ADC	Chip Select ADC
PA10	0	HATCH_ON	Powering the Hatch
			Sensing if Hatch does
PA11	l	HATCH_IN1	open
			Sensing if Hatch does
PA12	I	HATCH_IN2	open
PA13	JTAG	TMS	Programming
PA14	JTAG	TCK	Programming
PA15	JTAG	TDI	Programming
PB0	ADC	ADC2\$1	A/D Sensor 2
PB1	ADC	ADC2\$2	A/D Sensor 2
PB2	I	HATCH_DONE	Sensing if CAP is charged
PB3	JTAG	TDO	Programming
PB4	JTAG	RST	Programming
PB5	1	LO	REXUS-Interface
PB6	I2C1 (TEMP)	SCL	Temperature Measure
PB7	I2C1 (TEMP)	SDA	Temperature Measure
PB8	LED_SOE		-
PB9	LED_STATUS		-
	USART3(RS232,		
PB10	RS422)	TX	RS232-RS422
	USART3(RS232,		
PB11	RS422)	RX	RS232-RS422
PB12	SPI2(SD Card)	NSS	-
PB13	SPI2(SD Card)	SCK	-
PB14	SPI2(SD Card)	MISO	-
PB15	SPI2(SD Card)	MOSI	-
PC0	ADC	ADC2\$3	A/D sensor 2
PC1	ADC	ADC2\$4	A/D sensor 2
PC2	ADC	ADC3\$1	A/D sensor 3
PC3	ADC	ADC3\$2	A/D sensor 3
PC4	ADC	ADC3\$3	A/D sensor 3
PC5	ADC	ADC3\$4	A/D sensor 3
PC6	PGA1\$1	0	Measure Range Sensor 1
PC7	PGA1\$2	0	Measure Range Sensor 1
PC8	PGA2\$1	0	Measure Range Sensor 2
PC9	PGA2\$2	0	Measure Range Sensor 2
PC10	PGA3\$1	0	Measure Range Sensor 3
PC11	PGA3\$2	0	Measure Range Sensor 3
	· - · ·		23.23.23.30.00.00.00.0



PC12	0	Hatch_Charge	
PC13	0	BAT_ON	
PC14	Quarz	OSC -	
PC15	Quarz	OSC -	
PD0	Quarz	OSC -	
PD1	Quarz	OSC -	
PD2	-		

## JTAG-Interface

We use a 20-Pin JTAG interface for programming. Olimex standard layout for easy programming via an Olimex ARM-JTAG.

#### **RS-232**

We use this interface is only used for testing. Via jumper you can choose between RS-232 and RS-422. Different gage converter support both interfaces.

### **REXUS-Interface (RS-422)**

This interface for sending data up and down. Via jumper you can choose between RS-232 and RS-422. Different gage converter support both interfaces.

#### **D/A-Controller**

The D/A Controller is for setting the right sensor temperature and sensor voltage. Additional Information can be found in paragraph:

#### **Sensor Module**

This is a separate PCB-Board. All connections are provided by the Power-Bus and Measure-Bus systems.

#### A/D Controller

We use an external ADC for additional AD-Ports and because of higher resolution. Because of precise pressure sensors onboard we need to support an higher resolution than the internal 12 Bit. Additional we get feedback about power consumption and battery voltage level.

#### **SD-Card**

The SD-Card is for data storage. We are not able to send all data down while flying, so data is kept on a SD-Card. The reject mechanism of the SD-card socket is good but for safety it has to be locked by some glue additionally.



# **Power-Bus**

We use a Power bus that connects all boards and provides the different voltage levels where needed. High current or critical voltage levels as well as the GND are at least doubled on this bus. There are some uncritical Signals on this bus-system like I2C, powering the battery and measuring of voltage too.

Table 4-7: Power BUS: pin configuration

Pin	Signal	Pin	Signal2	used for:	Туре
1	GND	2	GND		-
3	I2C1_SDA	4	I2C1_CLK	SDA of the mainboards 1 or 2	Digital
5	I2C2_SDA	6	I2C2-CLK	CLK of the mainboards 1 or 2	Digital
7	GND	8	GND	-	-
9	I_REX_SENS	10	3V7	Current Sense / 3.7V Battery Connection	Analog
11	I_BAT_SENS	12	BAT_HEATING	Current Sense / Heating Command	Analog
13	GND	14	GND	-	-
15	5V	16	5V	5V Supply	Low Current
17	12V	18	12V	12V Supply	Low Current
19	-12V	20	-12V	-12V Supply	Low Current
21	24V	22	24V	24V Supply	Low Current
23	12V_BAT	24	12V_BAT	12 Volt from Battery	High Current
25	12V_RX	26	12V_RX	12 Volt from Rexus	High Current
27	GND	28	GND	-	-
29	RX_CHARGE+	30	RX_CHARGE-	28V connection between RX-battery interface and battery charger	High Voltage
31	RX28V	32	GND_RX	RX_Interface to Powerboard	High Voltage
33	RX28V	34	GND_RX	RX Interface to Powerboard	High Voltage



Table 4-8: Power BUS: pin configuration

Pin	Signal	Pin	Signal2	used for:	Туре
1	GND	2	GND		-
3	I2C1_SDA	4	I2C1_CLK	SDA of the mainboards 1 or 2	Digital
5	I2C2_SDA	6	I2C2-CLK	CLK of the mainboards 1 or 2	Digital
7	GND	8	GND	-	-
9	I_REX_SENS	10	3V7	Current Sense / 3.7V Battery Connection	Analog
11	I_BAT_SENS	12	BAT_HEATING	Current Sense / Heating Command	Analog
13	GND	14	GND	-	-
15	5V	16	5V	5V Supply	Low Current
17	12V	18	12V	12V Supply	Low Current
19	-12V	20	-12V	-12V Supply	Low Current
21	24V	22	24V	24V Supply	Low Current
23	12V_BAT	24	12V_BAT	12 Volt from Battery	High Current
25	12V_RX	26	12V_RX	12 Volt from Rexus	High Current
27	GND	28	GND	-	-
29	RX_CHARGE+	30	RX_CHARGE-	28V connection between RX-battery interface and battery charger	High Voltage
31	RX28V	32	GND_RX	RX_Interface to Powerboard	High Voltage
33	RX28V	34	GND_RX	RX Interface to Powerboard	High Voltage



### **Measure Bus**

This bus exists twice. One between Mainboard A and Sensor board A, the other between Mainboard B and Sensor board B. They are identical.

Table 4-9: Measure BUS: pin configuration

Pin	Signal	Pin2	Signal2	Kind of signal
1	AGND	2	AGND	AGND directly connected to uC
3	ADC1\$1	4	ADC1\$2	sensor1
5	ADC1\$3	6	ADC1\$4	sensor1
7	DAC1\$1	8	DAC1\$2	sensor1
9	ADC2\$1	10	ADC2\$2	sensor2
11	ADC2\$3	12	ADC2\$4	sensor2
13	DAC1\$1	14	DAC2\$2	sensor2
15	ADC3\$1	16	ADC3\$2	sensor3
17	ADC3\$3	18	ADC3\$4	sensor3
19	DAC3\$1	20	DAC3\$2	sensor3
21	PGA1\$0	22	PGA1\$1	gain select sensor 1
23	PGA2\$0	24	PGA2\$1	gain select sensor 2
25	PGA3\$0	26	PGA3\$1	gain select sensor 3
27	GND	28	GND	GND connected to GND

# 4.6.2 Sensor circuits (Sensorboard)

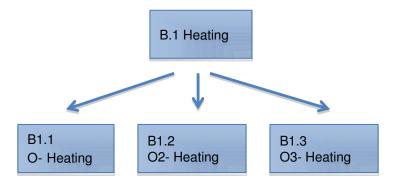


fig. 38: Control & Data Flow diagram of the different sensors



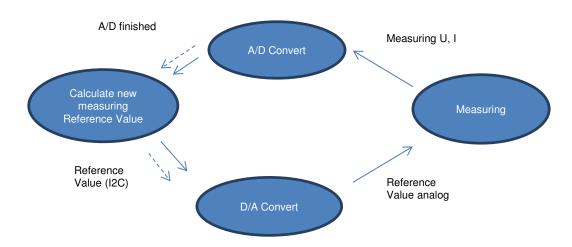


fig. 39: Control & Data Flow Diagram of Sensors Measuring

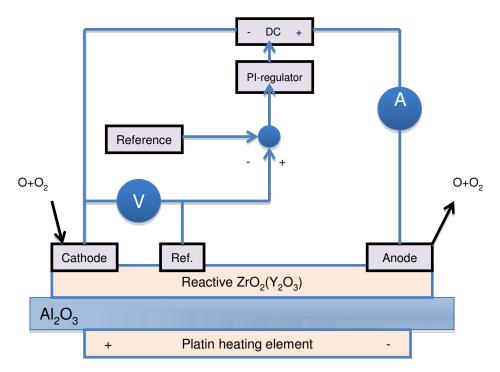


fig. 40: Control & Data Flow Diagram of sensors measuring and feedback control

The FIPEX sensor gets heated to a temperature about 650°C by a platinum-filament heating. This temperature has to be stable for at least one minute for atomic- and O2 sensors and 15 minutes for O3 sensors before measurement to eliminate contaminations on the sensor surfaces.

# Voltage regulation:

This is done by setting a voltage between cathode and anode. Now the voltage between reference electrode and cathode is measured and compared with the reference voltage. The difference between those two signals sets the input of the



PI-Controller. The PI-Controller now adjusts the voltage. The current at the anode correlates directly with the amount of oxygen witch impinges on the substrate.

You can find the PDF document for circuits and board layout as well as the part lists at Annex C.

# 4.6.3 Power design ( Powerboard)

You can find the PDF document for circuits and board layout in Appendix C.



#### 4.6.4 Temperature measurement

We support the temperature standard sensor LM75 on all PCBs inside our electronic box via I2C. We have little modules (11 mm x 11 mm) that can be connected via a small connector (JST-SH connector). You can find the pdf document for circuits and board layout in Annex C

#### 4.6.5 Sensor boards

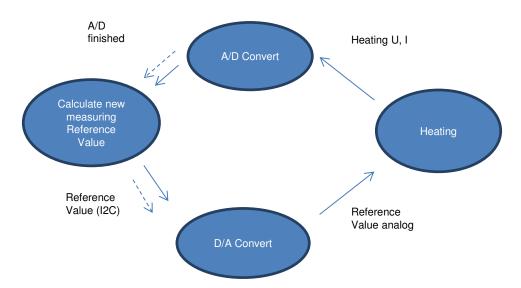


fig. 41: Control & Data Flow diagrams of sensors heating

Heating and measuring is nearly similar for O, O2, O3, the only difference is, that there is no reference electrode needed for ozone and O2 measuring.

You can find the PDF document for circuit and board layout in Annex C

#### 4.6.6 Connectors

For connecting the circuits, we use mainly 2 different connectors manufactured by MOLEX and JST. We use the Molex standard KK CME Connectors in 2.54mm width. The Headers do have voided back walls and friction locks, that provide additional polarisation feature and mate retention. On the other hand we use JST-SH connectors that can be mounted at TU-Dresden for all signals etc. Here is a table of all connectors we use inside our rocket-module:



# **Table 4-10: Connectors**

		Connector		Connector	Connect		Kind of	
Num	Name	Side A:	Connect to:	Side B	to	Lenght	cable	Weight/g
					Sensor			<u> </u>
1	Sens1\$1	Molex	Sensorboard 1	Molex	AO Hatch	300mm	5 AWG24	11,2
					Sensor			
2	Sens1\$2	Molex	Sensorboard 1	Molex	O2 Hatch	300mm	5 AWG24	11,2
					Sensor			
3	Sens1\$3	Molex	Sensorboard 1	Molex	O3 Hatch	300mm	5 AWG24	11,2
					Sensor			
				_	AO			
4	Sens2\$1	Molex	Sensorboard 2	Molex	Cavity	300mm	5 AWG24	11,2
					Sensor			
_	C262	N.AI	Camarahaand 2	N.4 - I	O2	200	E AVA/C24	44.2
5	Sens2\$2	Molex	Sensorboard 2	Molex	Cavity	300mm	5 AWG24	11,2
					Sensor O3			
6	Sens2\$3	Molex	Sensorboard 2	Molex	Cavity	300mm	5 AWG24	11,2
0	361132.73	IVIOIEX	Selisorboard 2	Sensor-	Pressure	30011111	3 AVV 024	11,2
7	Pressure 1	JST-SH-4	Mainboard 1	Plug	Hatch	300mm	4 AWG28	14
,	11035410 1	331 311 4	Widinboard 1	Sensor-	Pressure	30011111	47111020	<u> </u>
8	Pressure 2	JST-SH-5	Mainboard 1	Plug	Cavity	300mm	4 AWG28	14
		Crimp-		Crimp-			2 min	
9	Battery	Hülse	Powerboard	Hülse	Battery	100mm	AWG10	25
	Magnet				Magnet			
10	Control	JST-SH-4	Mainboard 1	JST-SH-4	Control	200mm	4 AWG28	14
11a-	Temperat				Tempera			
С	ure LM75	JST-SH-4	Mainboard 1	JST-SH-4	ture sens	100mm	4 AWG28	42
11d-	Temperat				Tempera			
f	ure LM75	JST-SH-4	Mainboard 2	JST-SH-4	ture sens	100mm	4 AWG28	42
	Temperat							
4.2	ure	Solder to	N 4 = to b = = o o l 4	ICT CLI 4	Sensor	200	4.444.630	4.4
12	PT1000	Thermod 1	Mainboard 1	JST-SH-4	T1 Hatch	200mm	4 AWG28	14
	Temperat ure	Solder to			Sensor			
13	PT1000	Thermod 2	Mainboard 2	JST-SH-4	T2 Cavity	300mm	4 AWG28	14
13	1 11000	Crimp-	Magnet	Crimp-	12 Cavity	30011111	2 min	7.4
14	CAP	Hülse	Control	Hülse	CAP	150mm	AWG10	25
	<i>3</i> ,		30		Mainboa	200111111	010	
15	Photo	Solder	Photosens	JST-SH-4	rd	300mm	4 AWG28	14
	ARM-				Magnet			
16	PLUG	Solder	ARM-PLUG	Solder	Control	180mm	5 AWG28	25
	Magnet	Crimp-	Magnet				2 min	
17	Power	Hülse	Control	Solder	Solenoid	200mm	AWG10	25
							Total	
							Mass [g]:	335,2



# 4.7 Thermal Design

The thermal design is split in four parts. The temperature in the hatch, the inner chamber, the parts which are mounted in the module and these which are not in contact with the ambient air stream. The fourth part is the interplay between the electronic boards and the electronic box.

### Temperature of the hatch

The hatch will not open until an altitude of 30 km is reached. Because of the low density in this altitude the friction on the lower edge of the now opened cavity is very low. That means that the hatch has to handle the temperature of the airstream that will be 120°C (outer shape of the rocket, measured on RX 11).

Therefore the hatch has to guarantee functionality between -20 and 120°C

During reentry, the hatch is open, hot gases hitting the parts which are looking in the airstream. At this state of the flight we don't want to measure anymore and we don't care if a sensor breaks. But hot gases must not come in the module itself. For that every way into the module is secured by heat resistant components.

Therefore the hatch has to guarantee leak tightness from -20 to 200°C.

Because the hatch is the only assembly group with moving parts there is a dilatation calculation in appendix C.

Table 4-11: temperature profiles of components of hatch

Part	Temperature in °C
In-house production(AIMgSi1)	melt at +585
Photo sensor	operating at-25 to 55 protected by hatch during hot flight phase
Solenoid	Operating temperature up to +300
Gas sensors	Work on up to +500
Pressure tube	Operating up to 1200
springs	Operating temperature -40 to 120
shafts	Medium thermal expansion coefficient at 200°C is $12.5 \times 10^{-6}$ m/K
slide bush	Operating temperature -100 up to +250
Sealing compound	Operating up to +300



### <u>Temperature of the inner chamber</u>

The inner chamber has a very small inlet (2.54mm hole), but the air could stream very fast. So in worst case the inner chamber has to handle 250 °C. This is an assumption because real behavior of the airstream is very hard to calculate. The pressure difference between in and outlet could be up to one bar, but many influences like wall near effects and inaction of the stream prohibit a good calculation. We estimate the highest temperature with up to 250°C.

The inner chamber and the bond should be able to handle temperatures of -20 to 250°C

The Ramp outside should handle -20 to 600°C to be sure that the ramp wont separate from the module and damage the rocket.

Table 4-12: temperature profiles of components of inner chamber

Part	Temperature in °C
In-house production (AIMgSi1)	melt at +585
Ramp(X5CrNi18-10)	Medium thermal expansion coefficient at $500^{\circ}$ C is $18x10^{-6}$ m/K
Gas sensors	Work on up to +500
piezo sensor process attachment	Operating -25 up to +85
Sealing compound	Operating up to + 300
High temperature adhesive	Operating up to +982



## Parts mounted in the module(except electronic box)

Inside the module we know that the temperatures, measured on the transmitters, having their maximum at 43°C.

All parts inside the module should be able to handle temperatures of -20 to 50°C

Table 4-13: temperature profiles of components in module

Part	Temperature in °C
In-house production(AIMgSi1)	melt at +585
Battery	Operating from -20 up to +60
Battery rubber for fixation	Up to +100
Battery Fixation (steel)	Up to 1600
Piezo sensor	-40 up to +85
Pirani sensor	Operating +5 to +50
Pilatii Selisoi	Storage -20 to +70
Pirani fix. dampers	operating from -20 to +80
Pirani fix. Frame(AlMgSi1)	melt at +585
cables	Operating Up to +60
cable fixation	Up to +100
Sealing compound	Operating up to +300
Boxes for FYMTS	Melting at +660
and board for hatch opening	iviciting at 7000

## <u>Interplay between the electronic boards and the electronic box</u>

The heat which the electronics will produce and emit is hard to calculate so it will be tested.

So we determine no temperature range, but we show that the box can suffer the temperature and later, after the tests show how much heat the electronic will produce, to be sure everything will work or change the design.

Table 4-14: temperature profiles of components of the electronic box

Part	Temperature in °C
In-house production(AIMgSi1)	melt at +585
Distance pieces(steel)	Up to +1600
Foam for fiction	Operating -20 up to +105
Cable outlet	Operating at -20 up to +85

#### <u>Screws</u>

All screws are made of steel and will handle the temperature profile.



**Table 4-15: Heat Power Generation** 

Part	Power dissipation	Urgency
Switching Regulator	40 mW	normal
DC/DC 3.3V	750 mW	high
DC/DC 5V	3000 mW	very high
DC/DC +/- 12V	750 mW	high
uController	95mW	low

Temperature of the elements will be lowered by a heat sink design for the DC/DC Converters (direct connect to the aluminium case), by thermal vias and heat pads below the board for smaller thermal losses (microcontroller, switching regulators).

# 4.8 Power System

#### 4.8.1 Power dissipation

The anticipated power dissipation is mostly caused by the sensors heating. The sensors resistance and therefore the power dissipation varies widely depending on the temperature of the platinum resistance and energy dissipated by heat convection.

The power dissipation of the sensors varies widely between the maximum value at startup with about 5 Watts, and the mean dissipation of about 0.95 Watts measured in high vacuum chamber.

During the flight power dissipation will vary between this two sizes in dependence of mass flow over the sensor surface and barometric pressure.

The heating element is made of platinum. The dependence between resistor and temperature is listed below.

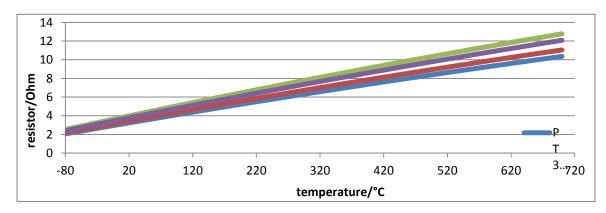


fig. 42: Resistance (Min-Max) calculation



To allow sensor calibration and removing of sensors contamination, the sensors will be heated up before the TO. Therefore, the highest power dissipation will occur before the launch, if all the sensors get heated up at once (6x 5 Watts). A lower power dissipation is expected during the first flight phase (0-30km) and the lowest at around the top. (6x1 Watts).

The maximum power dissipation during low pressure atmosphere will be estimated around 31 Watts in total by using battery supply and around 37 Watts by using the REXUS power interface.

Table 4-16: Overview Dissipation

			Total		
Part	Voltage	Current	Dissipation	Count	Dissipation
uController	3,300 V	29 mA	95 mW	2	190 mW
uC peripherie	3,300 V	10 mA	33 mW	2	66 mW
Fipex sensor heat	7,000 V	673 mA	4711 mW	6	28266 mW
Shunt	0,020 V	673 mA	13 mW	6	81 mW
MOSFET	0,020 V	673 mA	80 mW	6	480 mW
Measurement Peripherie					
(current side)	12,000 V	10 mA	120 mW	6	720 mW
Measurement Peripherie					
(voltage side)	12,000 V	10 mA	120 mW	6	720 mW
Pressure sensore	12,000 V	20 mA	240 mW	1	240 mW
Temp. sensor	12,000 V	20 mA	240 mW	1	240 mW
DC/DC Loss					6000 mW
Total Dissipation					37082 mW

To avoid excessive power usage, two possible designs can be implemented. The alternative switched heating might be implemented, but can only be used before the actual measurement. The second design includes batteries to lower the power withdrawal of the REXUS I/F.

# 4.8.2 Power System Design

High current batteries will be used to provide additional energy. A space-certified Lilon battery will be used. For safety, it will be placed in a separated compartment inside of the boardbox.

Assuming an average consumption of 20 Watts and a safety factor of 2, the required battery capacitance results to:

$$W = Q * U$$

$$Q = \frac{W}{U} * t = \frac{20W}{3.75V} * 12min * 2 * \frac{h}{60min} = 2.133 \, mAh$$



The battery charging and handling will be implemented using an MAX8814 charging IC. The "Charging" line of the RX Interface will be used.

# 4.9 Software Design

### 4.9.1 Experiment Software Design

Each experiment will have their own Microcontroller and data system to create independence. The Experiments are controlled manually before LO and by Timeline after LO. According manual command for the *Sensors Heating* can be sent by the ground station. Automatic flight events like *Measurements*, *Data Acquiry*, *Shutdown* are controlled by an timeline. The opening of the hatch is controlled by MORABA.

In case of any reset the LO Signal will be analysed first and with LO present the measurements and data acquiry will immediately start.

The timing will be synchronized to the LO signal and data capture and acquiry will be performed. The timeline corresponds directly with Table 4-1.

**Table 4-17: Software Timeline** 

ToF [s]	-1000	-900	0	50	350	600
Height	0	0	0	40	5	0
Heating						
Measurement						
Hatch				Χ		
Shutdown					Χ	
Manual Events	Power ON	Heating				Power OFF
Software State	IDLE	HEATING_O	FLIGHT	FLIGHT	FLIGHT	STOP

Table 4-18: List of Implemented States (Moxa Experiment)

#	State	FLIGHT STATES	Description
0	SETUP	Х	Used at Controller Startup
1	IDLE	Х	No Action is taken
2	HEATING_ONLY	Χ	Heating is Active (PreLaunch)
3	MEASURE		Measurement is active
4	<u>FLIGHT</u>	Χ	Measurement is active with Time Synchronization
5	STOP	Х	All Parts are Stopped
6	TEST,		Various Assembly Test Modes
7	TESTPINS		All Output Pins will blinks.



#### 4.9.2 Microcontroller Placement Considerations

Two autonomous measurement environments. Supplemental data transmission (1/s) from 1 out of 2 measurement devices.

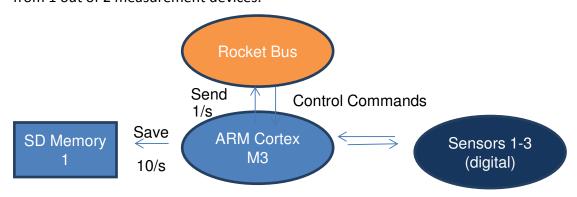


fig. 43: Microcontroller Placement Considerations

### 4.9.3 Software Flow Diagram

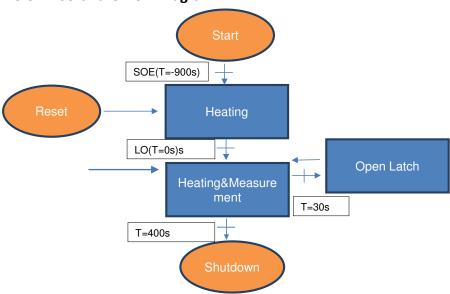


fig. 44: Software Flow Diagram

### 4.9.4 Implementation of a Minimalistic Operating System (MOS)

Minimalistic Operating System with continuous scheduler and basic task overview. The different flight states are represented in the microcontroller using a state machine to perform the according tasks.

The following figure shows the basic flow of the onboard microcontroller software. The control loop and the scheduler (housekeeping) tick rate confirm to real time operation as described in the requirements (10Hz) by using interrupts. Other components are driven with the lowest achievable latency.



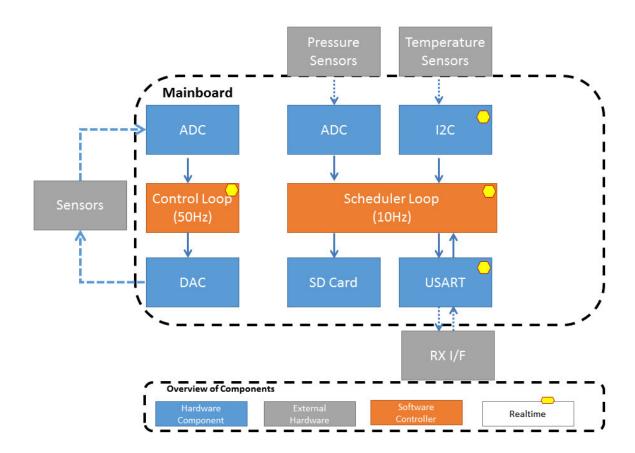


fig. 45: Implementation of a Minimalistic Real Time Operating System (RTOS)

#### 4.9.5 Data Communication Implementation

Active time of flight measurement during 300s with 10Hz will results in 3000 Measurements. By efficient compression of data all packages will be send down to the ground station as redundancy for SD-card failure. The overall measurement data per measurement is roughly 150 Byte, and hence 1500 Byte/s.

#### 4.9.6 Data Protocol Implementation

According to the REXUS experiment documentation a data protocol has been implemented.

A 16Bit CRC-CCIT (0xFFFF) algorithm has been implemented at ground station at all communication participants to check for bit errors. The upstream and downstream protocol use different package sizes, since upstream is solely required for commanding and does not carry many data. Each message consists out of a 6 Byte header, containing the identifying Message ID (MSGID) as well as a consecutive message number. In addition a 2 Byte CRC is included, containing the CRC for all data after SYNC.



Table 4-19: Description of 30-Byte Data Package (Downstream)

SYNC	SYNC	MSGID	MSGCNT	DATA023	CRC	CRC

Table 4-20: Description of 22-Byte Data Package (Upstream)

		SYNC	SYNC	MSGID	MSGCNT	DATA015	CRC	CRC
--	--	------	------	-------	--------	---------	-----	-----

A upstream command protocol will be used that allows setting of all elementary experiment parameters by remote, most significantly the status and control parameters, and allows remote triggering for the hatch and the sensors.

#### 4.9.7 Control Loop

An digital PID controller has been implemented to control the heating. The process parameters are flexible and can be adjusted before launch. For good performance the control route parameters are determined experimentally and will then be used to establish the PID parameters using an analytic model with SIMULINK software.

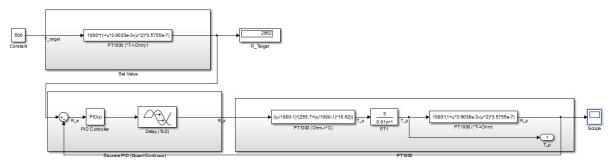


fig. 46: Analytic Simulink Model of the Heating with quasi-continuous PID controller

### 4.9.8 Ground Station Software Design

The ground station will be used to survey and save the received measurement data. The ground station software is developed in Java language. To access serial features, the RXTX Library will be used. For visualisation the open JFreeChart library is used. All commands can be executed by sending an ASCII Code through a serial interface.

- Start/Stop Heating
- Start/Stop Sensors
- Set Experiment Parameters (Control Parameters)
- Start/Stop Battery
- Read/Save all Analog Values (Currents, Voltages, Pressures)
- Read/Save all Temperature Values



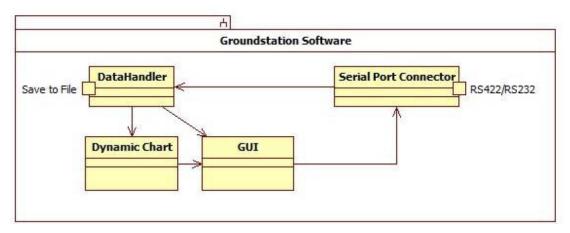


fig. 47: UML Diagram of Groundstation software classes.

The software is accessible online via a revision software (Git) to allow collaboration and sharing of the software with fellow/future teams.

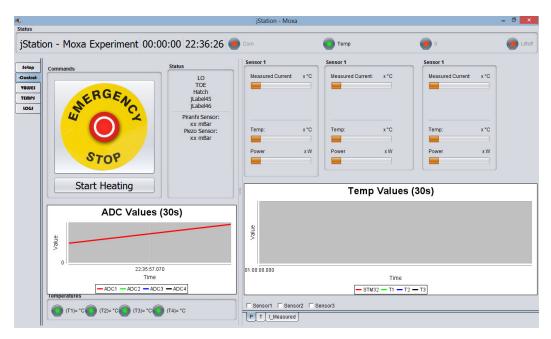


fig. 48: Preliminary GUI of the Ground Station

## 4.10 Ground Support Equipment

Two laptops: The ground support equipment will receive the data from the REXUS Interface and will analyse it for transmission error, process and save the data.

We need at launch site precise temperature and pressure data to correlate our measurements with atmosphere models.



## 5 EXPERIMENT VERIFICATION AND TESTING

## 5.1 Verification Matrix

## **Table 5-1: Verification table**

ID	Requirement text	Verification	Status
F.1	The experiment shall measure ozone on the outer shape of the RX rocket during the flight with two different electronic boards.	T, R	done
F.2	The experiment shall measure atomic oxygen on the outer shape of the RX rocket the whole flight with two different electronic boards.	T, R	done
F.3	The experiment shall measure molecular oxygen on the outer shape of the RX rocket the whole flight with two different electronic boards.	T, R	done
F.4	The experiment shall measure pressure on the outer shape of the RX rocket the whole flight with two different electronic boards.	T, R	done
F.5	The experiment shall measure temperature on the outer shape of the RX rocket the whole flight with two different electronic boards.	T, R	done
P.1	The ozone measurement (partial pressure) shall be possible between 10 <sup>-6</sup> bar and 1bar.	R	done
P.2	The ozone measurement (partial pressure) shall be made with an accuracy of 2% (between an attitude of 30 to 90km)	R	done
P.3	The ozone measurement (partial pressure) shall be made with an rate of 100 measurements every second	T, R	done
P.4	The atomic oxygen measurement (partial pressure) shall be possible between 10 <sup>-6</sup> bar and 1bar.	R	done
P.5	The atomic oxygen measurement (partial pressure) shall be made with an accuracy of 1% (between an attitude of 30 to 90km)	R	done
P.6	The atomic oxygen measurement (partial pressure) shall be made with an rate of 100 measurements	T, R	done



	every second.	
P.7	The molecular oxygen measurement (partial pressure) shall be possible between 10 <sup>-6</sup> bar and 1bar.	R done
P.8	The molecular oxygen measurement (partial pressure) shall be made with an accuracy of 1% (between an attitude of 30 to 90km)	R done
P.9	The molecular oxygen measurement (partial pressure) shall be made with a rate of 100 measurements every second.	T, R done
P.10	The pressure measurement shall be possible between 10 <sup>-4</sup> bar and 1,5 bar.	R done
P.11	The pressure measurement from 20mbar to 3 bar shall be made with an accuracy of 1.5%.	R done
P.12	The pressure measurement shall be made with an rate of 100 measurement every second.	T, R done
P.13	The temperature measurement shall be possible between -100°C and 200°C.	R done
P.14	The temperature measurement shall be made with an accuracy of +/- 1°C.	R done
P.15	The temperature measurement shall be made with a rate of 100 measurement per second.	T, R
P.16	The pressure measurement from 0.001 to 20mbar shall be made with an accuracy of 10%.	R done
P.17	The Experiment shall save and process the data at a rate of 10 Hz.	T done
P.18	The Experiment control loop shall process at 50 Hz.	T done
D.1	The experiment shall be designed to operate in the vibration profile of the RX rocket.	T done
D.2	The experiment shall be designed in such a way that it shall not disturb and harm the RX rocket and the other experiments.	T, I done
D.3	The experiment batteries shall be qualified for the rocket flight.	A done
D.4	The experiment batteries shall be rechargeable to run the experiment during pre-flight test, flight	T, A done



	preparation and flight.	
D.5	The experiment batteries interface shall be accessible for recharging.	done
D.6	The experiment sensors shall be reachable for a late exchange.	not possible
D.7	The experiment sensors shall be put on the outer shape of the rocket for a convenient approaching flow.	T, A, I done
D.8	The electronic boards have to be fixed and hedged against humidity and electromagnetic influences.	T, I done
D.9	The hatch shall work (opening time, mechanism).	T, I done
D.10	The heat, produced by the electric, shall be led away.	T done
0.1	The experiment shall operate automatically.	T done
0.2	The experiment shall release the hatch for the sensor protection automatically.	T done
0.3	The experiment shall accept a request for radio silence at any time while on the launch pad.	T done
0.4	The experiment shall store the measured data on a SD-card.	T done
0.5	The experiment shall send a part of the measured data down to the ground station.	T, A done
0.6	The experiment shall be able to turn off all electrical parts for landing.	T done
0.7	The experiment electrics shall control the sensors all the time.	T done
0.8	The sensors must not be touched when they are hot.	
0.9	The automatic events shall automatically triggered by Timeline after liftoff.	T done
0.10	The manual events shall be transmitted over the REXUS Interface	T done



## 5.2 Test Plan

Table 5-1: Test description T1

Test number	T1
Test type	Functionality
Test facility	TUD
Tested item	Hatch
Test level/procedure and duration	Qualification test
Test campaign duration	1 day

Table 5-2: Test description T2

Test number	T2
Test type	Electronic
Test facility	Not clear yet
Tested item	Curve for regulation parameter
Test level/procedure and duration	Qualification test
Test campaign duration	1 day



## Table 5-3: Test description T3

Test number	T3
Test type	Functionality
Test facility	TUD
Tested item	Sensors
Test level/procedure and duration	Acceptance test
Test campaign duration	21 day

## Table 5-4: Test description T4

Test number	T4
Test type	Vibration
Test facility	TUD, ZARM
Tested item	Assembled Experiment
Test level/procedure and duration	Qualification test
Test campaign duration	5 days

## Table 5-5: Test description T5

Test number	T5
Test type	Software
Test facility	None
Tested item	Microcontroller Software, Ground station Software
Test level/procedure and duration	Acceptance test
Test campaign duration	15 day



#### 5.3 Vibration Test

To ensure the safety of our module and assembly, we will do vibration tests with our complete module. The tests will take part at the Dresden University of Technology, previously it's necessary to prepare the tests in detail. All parts will be mounted for the tests on a vibration table, for inspection and functional checks we need relevant equipment.

#### **Module**

The testing of the module will take part after the final assembly of our module to ensure safety and functionality of our project. Inspection of structure, fixation of wiring and functional tests are necessary after each axis of vibration. The opening mechanism of the hatch has to be tested during every vibration test to ensure functionality after launch. Additional accelerometers for each axis need to be mounted onto the board box, the hatch and the pirani sensor.

#### **Pirani Sensor**

In order to check the efficiency and capacitance of the Pirani sensor, we will test the sensor within the whole module in functionality and simulate the conditions of the flight.

First we will check the qualification level of vibration, therefore it's necessary to mount accelerometers for each axis (X, Y and Z) and inspect the functionality of the sensor after the test for each axis.

#### **Search for Eigenfrequencies:**

Table 5-9: Sinusoidal frequency vibration

Axis	Frequency	Input Level
X,Y	5-2000Hz	0.25g
(Z	5-2000Hz	0.25g

Table 5-9:Random frequency vibration

Axes	Frequency	Remark	
All Axes (20-2000)Hz 6.34gRMS 0.018 g <sup>2</sup> /			
Duration	10s/10s/10s/60s		
%-Input	25%/50%/75%/100%		



During the Bench-Test at Oberpfaffenhofen a second vibration test was performed by DLR at a 12gRMS level to ensure the safety of the Hatch.

Test results are documented in the Appendix E.

#### 5.4 Thermal test

The thermal test consistent with the expected maximum and minimum of temperatures on each assembly group or measure the produced and emitted heat flow during operation (electronics).

During a test the emitted heat due to the operating electronics was measured. In the end the produced heat was harmless to the experiment.

Single components have been tested to their thermal sensitivity. But tests of the electronic box with the boards or the sensors were not possible due to the state of development of these parts.

#### 5.5 Test Results

#### 5.5.1 T5 Software Tests

- (P.3, P.6, P.9) The software is fast enough to control 100 Measurements/Second
- (D.9, O.1, O.2) Timeline events can be performed
- (O.3) The experiment can be deactivated by RX I/F(State Change)
- (O.4) Data can be captured & saved onto an SD Card
- (O.5) The RX I/F is implemented and working using upstream commands and downstreaming of measurement data
- (O.6) The Experiment can be deactivated automatically(Timeline)

The Test using a RS232 connection has been successful and proven that the necessary software parts are implemented as required beforehand, both on the experiments microcontroller as well on the groundstation.

#### 5.5.2 T4 Vibration Test

see APPENDIX E



#### 6 LAUNCH CAMPAIGN PREPARATION

## 6.1 Input for the Campaign / Flight Requirement Plans

#### 6.1.1 Dimensions and mass

Table 6-1: Experiment mass and volume

Attribute	Dimension
Experiment mass (in kg):	8.973kg including module and bulkhead
Experiment dimensions (in m):	Ø 0,348 x 0,130
Experiment footprint area (in m <sup>2</sup> ):	0,0657
Experiment volume (in m³):	0,012
Experiment expected COG (centre of gravity) position:	(x=137, y=106, z=0.191)

#### 6.1.2 Safety risks

Hot surface of one of the sensors (500°C) when heated. The risk occurs between t=-900s and t=600s during flight and during active tests which include heating of the sensors. Before launch and during testing the surface will be covered by the hatch and are not touchable. After Power-off the sensors cool down within seconds and are not hazardous during recovery. For additional safety a warning sign marks the area on hull.

The sensors will have a protective cap during tests.

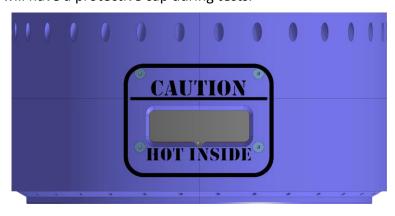


fig. 49: Warning sign at outer hull



### **Hatch safety issues**

It has already been mentioned, that the hatch will not be closed again. So it will be open during reentry and landing. To ensure that no hot gas will get access to the inner parts of the module we use some mechanism/parts.

When an airflow with over estimated 200°C flows permanent over the sensors (e.g. reentry) the sensor could be damaged, but this is set. Our goal is to get as much data as possible which means we measure till the sensors are damaged.

A weak point is the photo sensor. It is also made of plastic and could melt during reentry. The hole that arises due to that is protected with an aluminum box shown in the picture below.

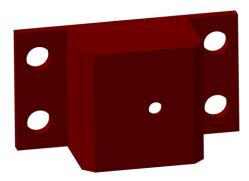


fig. 50: aluminium box

All contact faces between different parts or at places where cables will come through the structure will be secured with a paste that is temperature resistant.

Owing to the fact that the pyrocutter contains explosives there have to be some security constraints. To prevent early ignition and damage to men or material the electric circuit have to be capsuled and seperated from other cords.



#### 6.1.3 Electrical interfaces

REXUS Electrical Interfaces				
Service module interface required? Yes/No (usually yes)				
Number of service module interfaces:	Two			
TV channel required?	no			
If yes, when is it required:				
Up-/Downlink (RS-422) required? Yes				
Data rate - downlink:	19'2 Kbit/s			
Data rate – uplink	0 Kbit/s			
·				
Power system: Service module power required? Yes				
Peak power consumption:	50 W			
Average power consumption:	37 W			
Total power consumption after lift-off (until T+600s)	7 Wh			
Power ON	t=-1000s			
Power OFF	t=600s			
Battery recharging through service module:	Yes			
Experiment signals: Signals from service module required? Yes/N	No			
LO:	Yes			
SOE:	t=-900s			
SODS:	t=0s			

## **6.1.4** Launch Site Requirements

The Experiment must be kept above 7°C at all times to avoid freezing of the electrolyte within the sensors. Heating and Isolation to keep the temperature above



this level is necessary for transportation and launch pad during times without experiment power.

At the launch site we require at Liftoff:

- Local Temperature
- Local Pressure

## 6.2 Preparation and Test Activities at Esrange

- 1. Installation and test of our ground station equipment
- 2. Prove of integrity of all components after transport
- 3. Change/Installation of the battery
- 4. Change/Installation of all gas sensors
- 5. Test of the functionality of the hatch (pyrocutter)
- 6. Test of the functionality of electronics and the sensors
- 7. Secure the reject mechanism of the SD-Card with some glue
- 8. Use test signals from the REXUS bus and test the right reaction
- 9. Final fixation of the inner chamber with adhesive
- 10. All contact faces in the hatch between different parts or at places where cables will come through the structure will be secured with a paste that is temperature resistant.
- 11. Installation of the new pyrocutter
  Assemble everything for flight/ secure screws with LOCTITE see APPENDIX F for detailed information



#### 6.3 Timeline for countdown and flight

The Sensors used for this experiment need a time for preheating and calibration. This time is sensor-dependant and should take up to 15 minutes before the measurements and therefore should be performed before Lift Off. The protective hatch will be opened after the burnout of the motor.

**Table 6-2: Timeline** 

Time	Event			
T-1000	Power on			
T-900	SOE (Preheating of the sensors)			
T+0	Lift Off			
T+28	Hatch opening (Pyrocutter fired by service system)			
T+600	Power Off			

#### 6.4 **Post Flight Activities**

#### 6.4.1 **After Recovery**

6.4

- 1. Disassembly of the experiment and clean it/documentation
- 6.42. Disassembly of the electronic box, to get the SD-Card
  - 3. Examine all mechanical parts /documentation
  - 4. First analysis of data
- **6.4**5. Interpretation if the sensor worked or not
  - 6. Celebrate the hopefully successful launch ☺

#### **6.4**2 After launch campaign

- 1. Data analysis in detail
- **6.4**<sup>2</sup>. Functionality test of all components (sensors, electronic, material) 5. Final Report
- 6.4
- 6.4
- 6.4
- 6.4



#### 7 DATA ANALYSIS PLAN

### 7.1 Data Analysis Plan

We will start with a rough estimation in Kiruna if the sensors work or not.

After that we will analyse the gained data in cooperation with the Institute of Aerospace Engineering in Dresden. The result of this investigation will be a partial pressure against time diagram for every measured gas.

Then we will compare these data with the GPS data of REXUS, to get the partial pressure of each gas against flight altitude.

In comparison with the pressure we measured and the density against altitude we can calculate the density of each gas for every altitude.

Afterwards resulting distribution diagram will be compared with known data from various sources, to value the functionality of the sensors and the electronic control.

#### 7.2 Launch Campaign

After arriving in ESRANGE we shall inspect every part of the experiment.

First we disassemble every assembly group of the experiment, which screws are not secured with Loctite already.

After that just the electronic boards and software will be tested by their own to check if there is a possible damage caused by transportation. If these test run well the electronic boards will be connected to the sensors and tested as well.

In the end we shall simulate a flight using the RX simulator. After passing all tests the experiment will be assembled and secured with Loctite in the module.

After the flight we will start a rough estimation in Kiruna if the Sensor works or not.

#### 7.3 Results

### 7.3.1 Main goal

The main outcome of MOXA is that we built an experiment that is able to fulfil the scientific goal we announced in the proposal for the REXUS campaign. We wanted to measure primary ozone, atomic and molecular oxygen and secondary local pressure and temperature during the whole flight.

But what has to be discussed is the quality of the measurements. Mainly the thermodynamic flight environment was a cause for unexpected quality penalty of the data. This has to be discussed in detail with the gas sensor provider (ILR at TUD).



#### 7.3.2 Elektronic

Up to the moment we received the signal Start Of Experiment (SOE) all electronic systems worked well. The sensors did heat up properly and we received a status of our experiment every second via the ground station. Because of two similar ground stations we saw all 6 sensors, the temperature sensors and the pressure sensors – everything worked as expected and already tested at the bench test.

This did not change at liftoff and during the flight (except the sensors, but more about that later on).

On the point of view of an electrician it was a great success.

Problems:

None on electrical side

#### 7.3.3 Software

The Software was full working; we lost two of 14000 measured values so we can say this is a great success too! The ground station gave us live feedback for all sensors so we saw much more of the rocket flight even though the others stood on the radar hill and we sat next to a computer in the control room. It was quite a lot of gratification to watch the sensor graphs varying in dependence of the rocket height.

#### 7.3.4 Mechanic

#### Hatch:

During the flight the pyro cutter fired after it received the signal from the RX-bus. The cutter sliced the steel wire, which holds the hatch down, and then the springs could push the hatch up.

That the hatch really opened is confirmed by a photo sensor in the hatch, the vibration measurement of another experiment (FOVS) and you can hear it in the flight video (GoPro looking outside the rocket).

#### Inner Chamber:

The design of the inner chamber should enable to take samples of the ambient airstream around the rocket, slow the air down and make it so suitable for our gas sensors.

The design based on simplifications of the airstream. Tumbling caused by the rotation stabilized flight and the resulting dynamic boundary layer couldn't be predicted. But especially the boundary layer around the rocket leads to much lower fluid velocity which the inner chamber was not designed for.

In conclusion we assume very little air exchange in the chamber, but this has to studied in further investigations.



#### Pirani pressure sensor:

One of the most sensitive component is the Pirani sensor. This device sensor was designed for vacuum chambers in a laboratory and not for a rocket launch with high vibrations and a large temperature range.

To make the sensor suitable for our experiment we placed designed a damping bracket to avoid vibrations and placed it near the center of the bulkhead where a small temperature range was expected.

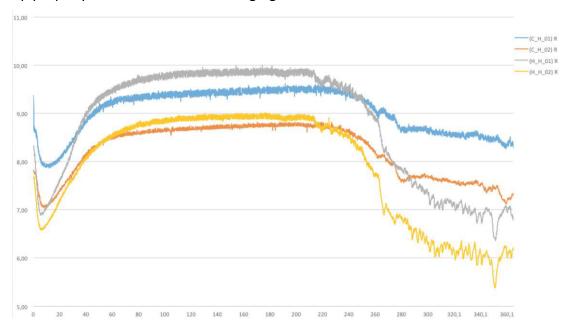
After the flight we recognized that the sensor is still operational. This means that the damping bracket even could handle the payload touchdown.

#### **Electronic Box:**

The box wasn't damaged and cared for the storage of the electronic boards very well.

#### **Gas Sensors:**

The results of the inner resistance of the sensors show, that the sensors did not heat up properly as shown in the following figure:



**fig. 51:** Sensor resistance during the flight

The figure 52 shows the inner resistance from liftoff till shutdown of the electronic (360s). At the beginning the high velocity cooled down the sensors. Our sensor control loop normally prevents that, but two things went wrong. On the one hand the PID values have not been that aggressive as they should be, so the control loop was too slow for the fast changing in air speed and density. The much more



important fact and the reason why our sensors have been cooled down so far is, that the current to a sensor has had to be regulated down to 500mA because of a bonding wire that is 0.025mm thick which is rated for at maximum that current. This would not have been a problem at all but the sensors we got from the institute have had very low inner resistances. Lower resistance means lower voltages (at same current) lower voltage at the same current means less power and therefore less heat. More bonding wires parallel would be able to capture a much higher current, but are very different to mount. So finally only the data between 80s and 220s are useable for upcoming data consideration.

#### 7.4 First Data Results

The figure 52 shows the pressure of the inner chamber and the hatch time resolved. The pressure of the hatch is marked blue and shows an inverted parabolic curve like our rocket flight, this is as expected. The black curve shows the same results at the beginning, what was very unexpected for us, because we expected a much higher pressure — maybe the hole at the ramp was to small, so there could not get enough air inside the chamber. As the sensor was not selected for that low values it is normal that it could not follow the blue line.

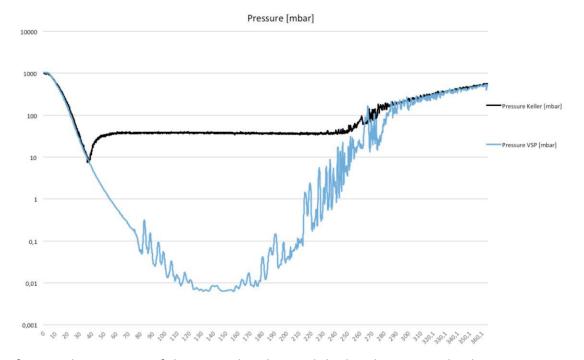


fig. 52: The pressure of the inner chamber and the hatch time resolved



In Figure 53 the time resolved ozone measurement is shown. The sensor in the hatch didn't work and the other one in the inner chamber slowly rise and jump to zero at 110 s. This trend could have several reasons, mentioned below. The ozone sensors are prototypes, that where finished two weeks before launch. In laboratory environment the sensors worked very well, but a rocket launch is a very harsh stress test for these sensors.

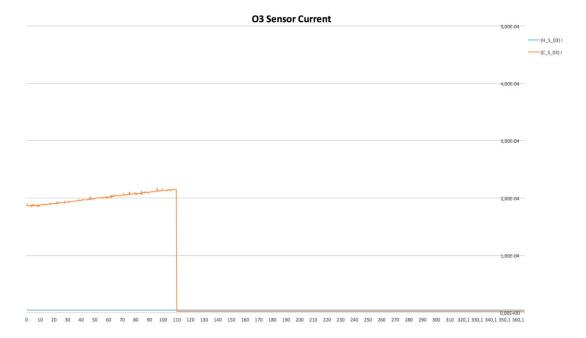


fig. 53: Ozone time resolved

The ozone sensor needs to be filled with a water carrying fluid to guarantee a permanent humidification of special foil. This foil and two electrodes measure incoming ozone. If the humidification is not stable or not available anymore the sensor does not work. The sensor itself and especially fluid inside could be influenced by varies factors:

- High velocity of the rocket (up to 1400m/s) and resulting airstream conditions that hits the sensor
- High acceleration (18g)
- Boundary layer effects on the rocket
- Different environments after inflation (integration hall; Launchpad; flight)
- High variations of local pressure and temperature during flight
- Mistakes during inflation or bonding

The sensors were installed protective as possible, but the extreme airstream conditions during flight couldn't be simulated. In Conclusion the prototype has to developed further, but we learned very much about the handling of the sensor.



#### 7.5 Discussion and Conclusions

In conclusion MOXA mostly fulfilled its objectives. There are two points that didn't worked as we expected. One is the sensor heating in the beginning of the flight and other one are the flow conditions in the inner chamber, as mentioned in chapter 7.3.4.

#### Conclusions:

- In this configuration the gas sensor are more suitable for low airstream velocities. This achieved partially in the inner chamber.
- Electronics and software operated very well and should be used for further operations of the gas sensors.
- The exact analysis of the measurements shall be done in a student research project.

MOXA was successful in the main intention of REXUS, because we learned so much about procedures of projects from the very first beginning of a proposal to the final presentation of the results. It was the first time for the most of us to get to know the difficulties and benefits of teamwork.

We would like to thank ZARM, DLR, ESA, MORABA and SSC for this great experience. We learned so much and we are glad that you make it possible to put our idea on your rocket.

Thank you!

#### 7.6 Lessons Learned

We learned very much, especially how an aerospace project has to be done from the very beginning to the end. Here is a list of the most important things:

- Very much about time management (project phases, manufacturing durations, testing procedures and even response time for e-mails)
- Define clear responsibilities in the team
- Team work is challenging
- Always review working packages in the team
- Weekly meetings, even when we didn't had so much to discuss, are mandatory



- Important points have to be mentioned again and again to make sure everybody understood them
- How to express the current project status in a presentation
- Take deadlines seriously
- Electronic engineers are rare but most important
- Working independently on a project besides our studies
- To elaborate the details is 90% of the work
- Double check production orders
- Learned a lot about Murphy's law



#### 8 ABBREVIATIONS AND REFERENCES

#### 8.1 Abbreviations

This section contains a list of all abbreviations used in the document.

Add abbreviations to the list below, as appropriate.

In version 5 of the SED (final version), delete unused abbreviations.

AIT Assembly, Integration and Test

asap as soon as possible

BO Bonn, DLR, German Space Agency
BR Bremen, DLR Institute of Space Systems

CDR Critical Design Review
COG Centre of gravity

CRP Campaign Requirement Plan

DLR Deutsches Zentrum für Luft- und Raumfahrt

EAT Experiment Acceptance Test
EAR Experiment Acceptance Review
ECTS European Credit Transfer System

EIT Electrical Interface Test
EPM Esrange Project Manager
ESA European Space Agency
Esrange Esrange Space Center

ESTEC European Space Research and Technology Centre, ESA (NL)

ESW Experiment Selection Workshop

FAR Flight Acceptance Review
FST Flight Simulation Test
FRP Flight Requirement Plan
FRR Flight Readiness Review
GSE Ground Support Equipment

HK House Keeping

H/W Hardware

ICD Interface Control Document

I/F Interface

IPR Interim Progress Review

LO Lift Off
LT Local Time
LOS Line of sight

Mbps Mega Bits per second
MFH Mission Flight Handbook

MORABA Mobile Raketen Basis (DLR, EuroLaunch)

OP Oberpfaffenhofen, DLR Center



PCB	Printed Circu	t Board	(electronic card)
-----	---------------	---------	-------------------

PDR Preliminary Design Review

PST Payload System Test

SED Student Experiment Documentation SNSB Swedish National Space Board

SODS Start Of Data Storage SOE Start Of Experiment STW Student Training Week

S/W Software

T Time before and after launch noted with + or -

TBC To be confirmed
TBD To be determined

WBS Work Breakdown Structure

AO Atomic oxygen
O2 Molecular oxygen

O3 Ozone

d.n.y Not clear at the state of development



### 8.2 References

(Books, Paper, Proceedings)

- [1] **Tino Schmiel:** Entwicklung, Weltraumqualifikation und erste Ergebnisse eines Sensorinstruments zur Messung von atomaren Sauerstoff im niedrigen Erdorbit. (2009)
- [2] S. Dikty, H. Schmidt, M. Weber, C. von Savigny and M. G. Mlynczak: Daytime ozone and temperature variations in the mesosphere: a comparison between SABER observations and HAMMONIA model. (2010)
- [3] Interface for atmospheric models: http://www.spenvis.oma.be/
- [4] Database of **geomagnetic indicies** and **solar indicies** as input parameters for atmospheric models:http://www.swpc.noaa.gov/ftpmenu/indices/old indices.html
- [5] **KYOUNGSIK CHANG**Analysis of the flow and mass transfer processes for the incompressible flow past an open cavity with a laminar and a fully turbulent incoming boundary layer (2006)
- [6] EuroLaunch: **BEXUS User Manual** (2012), **REXUS User Manual** (2012)
- [7] European Cooperation for Space Standardization ECSS: Space Project Management, **Project Planning and Implementation**, ECSS-M-ST-10C Rev.1, 6 March 2009
- [8] SSC Esrange: Esrange Safety Manual, REA00-E60, 23June 2010
- [9] European Cooperation for Space Standardization ECSS: Space Engineering, **Technical Requirements Specification**, ECSS-E-ST-10-06C, 6 March 2009
- [10] European Cooperation for Space Standardization ECSS, Space Project Management, Risk Management, ECSS-M-ST-80C, 31 July 2008
- [11] European Cooperation for Space Standardization ECSS: Space Engineering, **Verification**, ECSS-E-ST-10-02C, 6 March 2009
- [12] Project Management Institute, **Practice Standard for Work Breakdown Structures second Edition**, Project Management Institute, Pennsylvania,

  USA, 2006



## **APPENDIX A – EXPERIMENT REVIEWS**



## **REXUS / BEXUS**

## **Experiment Preliminary Design Review**

Flight: REXUS-15/16

Payload Manager: Mikael Inga/Alexander Schmidt

**Experiment:** MOXA

**Location:** DLR, Oberpfaffenhofen, Germany **Date:** 07 Feb 2013

#### 1. Review Board members

Andreas Stamminger (chair)

Martin Siegl (minutes)

Hans Henricsson

Mikael Inga

Markus Pinzer

Maria Roth

DLR – Mobile Rocket Base

DLR – Institute of Space Systems

SSC – Science Services

SSC – Science Services

DLR – Mobile Rocket Base

DLR – Space Administration

#### 2. Experiment Team members

Alexander Mager Patrick Geigengack Alexander Schultze

#### 3. General Comments

- Presentation
  - Very good presentation with lots of good information.
  - o Make sure to keep the time.
  - o Please explain the meanings of acronyms used in the presentation.
- SED
- o Make sure your document looks good (e.g. "Fehler: Verweisquelle...")
- Some sections are omitted fill all of them, if required with "N/A".
- Please accept our apologies for the wrong EuroLaunch-logo in the template. Please replace it on our behalf.

#### 4. Panel Comments and Recommendations

- Requirements and constraints (SED chapter 2)
  - Very good functional requirements.
  - o P.11.: Check the required accuracy.
  - o Design requirement: Status messages shall be sent to the ground station.
- Mechanics (SED chapter 4.2.1 & 4.4)
  - Use a 120mm or 150mm rocket module.
  - o Consider rearranging the PCBs and electronics boxes.
  - o Feed-through cable hole in the bulkhead requested.
  - o Current hatch design is interesting it can be implemented if it is tested

## thoroughly and early on in the project (breadboarding/prototyping before the CDR, vibration tests).

- Simplification of hatch design can be considered if it is not required to close: Use of pyrocutters or melting wires in combination with springs is recommended in this case.
- Pyrocutters of hatch could be controlled directly by the experiment (not by EuroLaunch).
- Positioning of vibration sensor should not pose a problem as the rocket is spinning at 4Hz.
- o Pirani sensor is critical in terms of handling consider a different, ruggedized sensor.
- Electronics and data management (SED chapter 4.2.2, 4.2.3, 4.5 & 4.7)
  - Use of uplink (on ground) is mandatory.
  - Use telecommands before LO, not signals (timeline before launch is not automated).
  - GPS data is only available after the flight.
  - More accurate definition of power budget required.
  - o Carefully describe the use of the on-board charging system, if required.
  - Hatches might be required to open with a short time difference to avoid high overall currents.
- Thermal (SED chapter 4.2.4 & 4.6)
  - Consider thermal design of the hatch.
- Software (SED chapter 4.8)
  - Software section is well developed.
  - Communication protocol might have to be refined.
- Verification and testing (SED chapter 5)
  - o Note that several tests will be scheduled prior to launch.
  - o Consider the use of safe-arm devices.
- Safety and risk analysis (SED chapter 3.4)
  - o Include project risks in the risk register.
  - DC/DC converter-related risk: a ranking of 4 is enough.
  - Risk of hot surface of sensor mitigated by low thermal capacity.
  - Hatch opening-related risk: Not critical to rocket (only experiment), ranking of 4 is sufficient.
- Launch and operations (SED chapter 6)
  - o Power on of experiments is at 600s.
  - o Consider how a hold in the countdown affects the experiment.
  - o Change of sensors after testing and before roll-out is recommended.
  - Extensive late access of rocket on the launcher is to be avoided by all means.
  - If required, a foil covering the hatches could be pulled off the rocket skin before launch.
  - Consider flushing with nitrogen.
- Organisation, project planning & outreach (SED chapters 3.1, 3.2 & 3.3)
  - o Table 6.1.1 is empty, please fill it.
  - o "Fly your message": Paper will get heavy, try to make it light and limit it.
  - Note that REXUS is not flying to outer space.
  - o Include an atmospheric physicist in your team, as discussed during selection.
  - o p.21: If most students stop by September this year, find additional team members.

#### 5. Internal Panel Discussion

- PDR Result: PDR passed
- Next SED version due:
  - Version 2 two weeks before CDR.



# **BEXUS Experiment Critical Design Review**

Flight: REXUS 15/16

Payload Manager: Alexander Schmidt or Mikael Inga

Experiment: MOXA

**Location:** DLR Oberpfaffenhofen **Date:** 26th June 2013

#### 1. Review Board members

Mikael Inga SSC Science Services

Martin Siegl (min.) DLR Institute of Space Systems

Alexander Schmidt DLR MORABA

Alex Kinnaird ESA Policies Dept. – Education and Knowledge Management Office.

Natacha Callens ESA Policies Dept. – Education and Knowledge Management Office.

Koen Debeule ESA Technical Directorate – Mechanical Engineering Dept., Test Centre Div.

Andreas Stamminger DLR MORABA
Markus Pinzer DLR MORABA
Frank Hassenpflug DLR MORABA

Maria Roth DLR Space Administration
Mark Fittock (chair) DLR Institute of Space Systems

#### 2. Experiment Team members

Alexander Mager (TL) Bastian Klose ???

 Daniel Becker
 Susann Knapik

 Patrick Geigengack
 Alexander Schultze

#### 3. General Comments

Presentation

The presentation clarified several items.

o Additional team members should stand with the team (not sit at the table).

- Some subjects were treated in too much detail, some other (like electronics) haven't been covered enough.
- Graph showing the timeline of flight is very good.

• SED

- Some information is hard to find / not located in the standard places.
- Use wording 'Exploded view', not 'Explosion view'.
- Write CoG, LoS, etc. (lowercase 'o')
- Document is not to be approved by Payload manager; should be approved by professor etc.
- o Document ID does not follow the naming convention.

#### 4. Panel Comments and Recommendations

- Requirements and constraints (SED chapter 2)
  - F.2 F.3 word 'during' is missing
  - Performance requirements are good.

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Formatiert: Deutsch (Deutschland)

- Design requirements have to be extended (power usage, weight, data rate, ...)
- Shortest design requirements list among all CDR SEDs.
- Mechanics (SED chapter 4.2.1 & 4.4)
  - Considerable progress since the last review.
  - Mechanical interface information should be collected in one place in the SED.
  - Hatch solution will still require improvement.
  - Consider using a linear actuator that would also allow closing of the hatch. ???? Solenoids may cause EMC problems (has been considered by the team).

  - Consider the risk of desoldered joints due to hot gas in the hatch compartment. 0
  - Perfect solution would be to open and close the hatch again.
  - Current hatch design requires an arm plug for testing.
  - Beware of thermal expansion with regard to manufacturing tolerances in the hatch.
  - Air inlets: Should be discussed with EuroLaunch (CDR panel not sufficient) 0
  - Steel wool poses risk of combustion in the module.
- Electronics and data management (SED chapter 4.2.2, 4.2.3, 4.5 & 4.7)
  - Deliver detailed electronics schematics.
  - Service module interface schematics not complete in the SED.
  - Capacitor: Should be included in the schematic, provide further details.
  - Consider sparking due to high voltage. Perform tests accordingly.
  - Test the vacuum compatibility of the capacitor.
- Thermal (SED chapter 4.2.4 & 4.6)
  - Thermal section severely lacking.
  - Provide details regarding the expected thermal environment, component ranges, etc.
  - Battery heating: Not required.
- Software (SED chapter 4.8)
  - Software risks are missing in the risk register.
  - Develop early, try not to wait for flight hardware to arrive.
  - Provide details on signals and timeline.
- Verification and testing (SED chapter 5)
  - Design requirement 3: Cannot be done by analysis.
  - Verify early and start with the easiest verification method. Verification should not rely on a single test in the end.
  - Most important tests (vibration/thermal) are covered correctly, but subsystem tests are missina.
  - o Details tests to be performed on the hatch.
- Safety and risk analysis (SED chapter 3.4)
  - Safety risk of steel wool combustion
  - Risk register: Rating of 5 partly unrealistic
  - Risk ratings are not consistent. 0
  - List of risks really limited.
  - Personnel, budget risks, and project risks are not included.
  - Hot surface risk not properly mitigated (e.g. safety covers etc.)
- Launch and operations (SED chapter 6)
  - Oscilloscope requirement: Note that no development work can be performed at Esrange.
- Organisation, project planning & outreach (SED chapters 3.1, 3.2 & 3.3)
  - Availability of team members critical after the summer: serious problem
  - Webpage: Include sponsors
  - In a blog/news list, the newest entry should be on top.
  - Clarify the meaning of the word "start" (should be launch). 0
  - Include the Final Report in the project plan.
  - Commitment (work hour) percentages have to be properly defined.
  - Include a sponsorship column in the budget overview.

Formatiert: Schriftartfarbe: Hellblau

Formatiert: Schriftartfarbe: Hellblau

- o Provide a complete budget.
- o Include all team members, also on the Facebook picture.
- o Fly your message will be 2-3 A4 pages.
- o Appendix B: add more information, add link to PDF copies.

### 5. Internal Panel Discussion

- Summary of main actions for the experiment team (see bold print)
- CDR Result: pass / conditional pass / fail
  - Conditional pass under the prerequisite that a new version of the CDR SED is submitted within 4 weeks, addressing all above points.
- Next SED version due
  - o Resubmission of SED within 4 weeks



#### APPENDIX B – OUTREACH AND MEDIA COVERAGE

#### **LIST OF APPEARING ARTICLES:**

- HI:TECH CAMPUS
- atp edition
- Die Welt
- TU Dresden
  - 1. Main Homepage
  - 2. Hompage of mechanical engineering
  - 3. Twitter
  - 4. Facebook
- Sachsische Zeitung
- Kanal 8
- Dresdner Neuste Nachrichten
- Bild online
- Unijournal
- Freie Presse
- CAZ
- LVZ online
- Mein Infodienst

#### **INTERVIEWS:**

- MDR Figaro
- Campusradio
   http://campusradiodresden.de/2013/01/31/vom-horsaal-ins-all/#more-5740

### **MEDIA:**

• Website: <u>www.rexus-moxa.de</u>

• Facebook: <u>www.facebook.com/rexus.moxa</u>

### Other:

- Buttons
- Posters
- Flyer
- Send your Message to space





fig. 54: MOXA Flyer

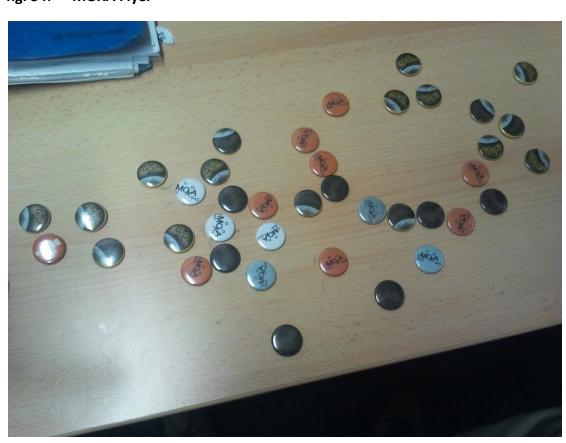




fig. 55: MOXA Buttons



fig. 56: article on TU Dresden homepage



## **APPENDIX C – ADDITIONAL TECHNICAL INFORMATION**

see PDF: SED 2.2 APPENDIX C



## APPENDIX D – REQUEST FOR WAIVERS



Students Experiment Document. MOXA Experiment RX16. TU Dresden.

# **APPENDIX E – VIBRATION TEST**

# **REXUS-MOXA**



Vibration Test Report

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### **Outline**

#### Introduction

This test report involves guidelines, organisation, execution and analysis to qualificate the REXUS-MOXA experiment. The vibration test was executed at the institution for light construction and plastics engeneering of the technical university of Dresden.

### **Test objective**

The aim of the vibration test is the safety case and the functional demonstration of the installation of the module and of the experimental set-up in direction of the X-, Y-, Z-axis with given vibration stain from the current REXUS User Manual.

Furthermore multiple tests with different experimental set-ups were executed on the sensitive Pirani-sensor.

Following tests were executed:

- Sinus eigen frequency search before Random conducted on each axis
- Random strain test conducted on each axis
- Sinus eigen frequency search after Random conducted in each axis
- Eigen frequency search with differently damped Pirani-Sensors
- Random tests in Z-direction with instantly applied full load as flight simulation
- Function tests of the mechanics

#### **Documents**

# Important points for the execution of the tests and strain levels

• Aktuelles REXUS User Manual;

Document ID: RX UserManual v7-11 08Jan14.doc

### Data sheets of the test equipment

Shaker-Systemdescription;

Document ID: 3000241D-V8-V3\_System.pdf

• Shaker-Softwaredescription;

Document ID: Dactron Software Beschreibung.pdf

PCB acceleration sensor;

Document ID: PCB-353B03.pdf

PCB acceleration sensor;

Document ID: PCB-M353B18.pdf

• Brüel&Kjaer 3-Axis acceleration sensor;

Documet ID: 4504A\_triaxial\_CCLD\_accelerometer.pdf

# **Test organisation**

The vibration test was executed at the institution of light construction and plastics engineering (ILK) in Dresden-Johannstadt. The necessary test equipment with software, sensor acceleration and required tools was provided. Furthermore the test adapter, which is a second little REXUS-module with a bulkhead for the test period, was provided from ZARM Bremen. The tests take 3 days and was executed on the 7th of January and 13<sup>th</sup> of January. The interposition occurred by Dr. Tino Schmiel and Paul Rossman from the institution of aerospace and space flight at the ILK.

### Cooperators

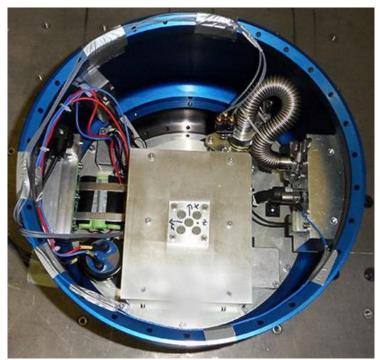
- Rainer Saalfeld, test bed leader of the ILK
- Alexander Mager, Team leader
- Nathanael Warth, Responsible for the test and mechanics
- Max Oswald, Mechanics
- Sebastian Weixler, Mechanics

#### **Ambience conditions**

During the tests the temperature was around 20°C, the relative humidity 55  $\pm 10\%$  at normal air pressure. The shaker stood in a big dead room with aeration. In each case a hydraulic pump was engaging to achieve a constant operating temperature.

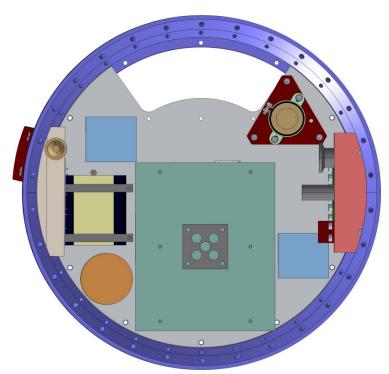
# **Test object**

The complete module was tested in the experiment organization which is complete for the flight. In order to the test it should be simulate a realistic behavior as possible. Except the boards, the oxide sensors and the skirt battery weren't used in this test. Boards and skirt batteries were replaced by dummies with an approximate similar mass and were built in like in the flight configuration. The oxide sensors could be neglected because of the low mass and the retain assembly.

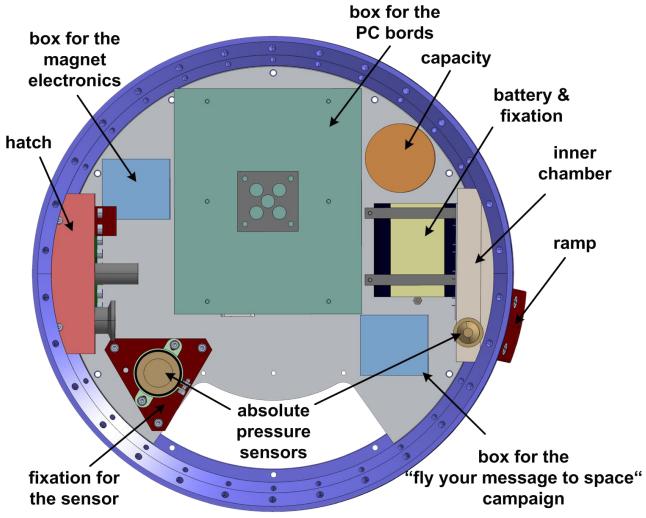


X Y

Picture 1: Test arrangement, X-Axis



Picture 2: Experiment organisation, X-Axis



Picture 3: Experiment organisation with components description, X-Axis

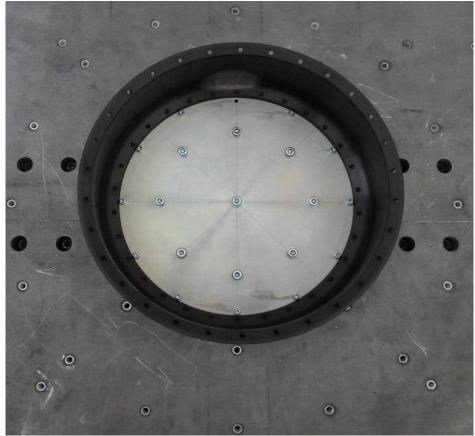
# **Test configuration**

# **Test equipment**

Nr.:	Equipment	Manufacturer
1	56kN Shaker System V8-440	LDS Dactron
2	Power amplifier SPA56K	LDS Dactron
3	Vibration adapter	Deutsches Zentrum für Luft- und Raumfahrt
4	Acceleration sensor	PCB, Brüel&Kjaer

# **Adapter of vibration**

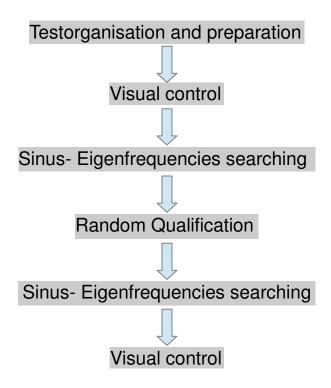
To realize a facsimile test behavior as possible the module which should be tested was screwed on a second, empty REXUS-module. Thereby it was achieved an almost original fixing. The lower empty module was screwed over his own bulkhead (ground) with the vibration desk.



Picture 4: Vibration adapter on the vibration desk

### **Test process**

The test process for the X, Y, and Z-Axis was in each time as follows:



#### Visual control

During the visual control the components, cable management and all boltings were checked before and after every test run for subsidence, damage and bulking blasting phenomenon.

# **Test requirement**

The vibration test for the module is passed if following points are given:

- For each axis (X, Y and Z) the test was executed according to the test run and the particular results logged
- The defined test values which are fixed in the tables 6.4.1 and 6.4.2 were achieved in all axis directions
- The eigen frequency progress before and after the particular random tests accord approximately and show:
  - o Relative to the resonance frequency discrepancies are less than ± 5%
  - o Relative to the strain at resonance frequency displacement is less than ± 25%
- The visual control after every test run doesn't show hardware damages or other damages

# Test structure and sensor configuration

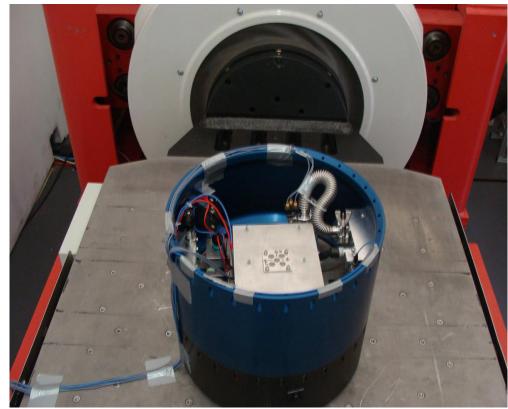
#### Test structure on the shaker

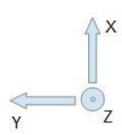
The module was mounted on a test adapter with 30 M5x16 cheese head screws with hexagon socket. The clamping torque betrug 5,4 Nm (maximal allowed 6,5Nm).

The test adapter was screwed on the vibration desk with 9 M8 cheese head screws with hexagon socket and 24 Nm of clamping torque for the X- and Y-tests. All screws were fixed with a dynamometric key.

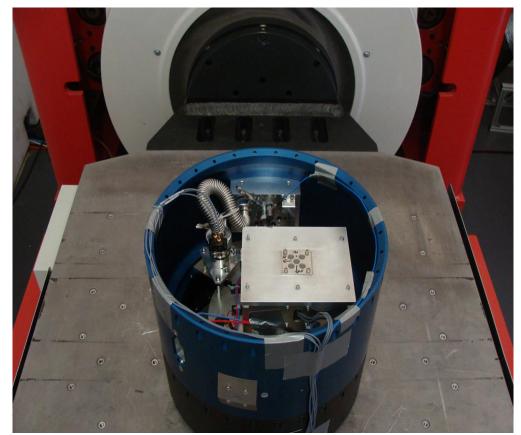
Between the bulkhead of the adapter and the vibration desk is a distance of 8mm. That's why around every 9 screws was laid a big M10 screw nut (height 7,8mm) to beware a bending and so a damage of the bulkhead and of the adapter module. The 30 cheese head screws were released for the conversion from the X- to the Y-axis. Then the test module was turned by 90° to the left and stabilized again.

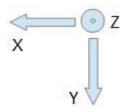
The swing unit was disconnected with the vibration test for the Z-axis test and was straighten up from the horizontal to the vertical. The adapter with test module was screwed directly on the swing unit for the Z-axis. The reason for this procedure is that the swing unit uses the same mount as the vibration desk.



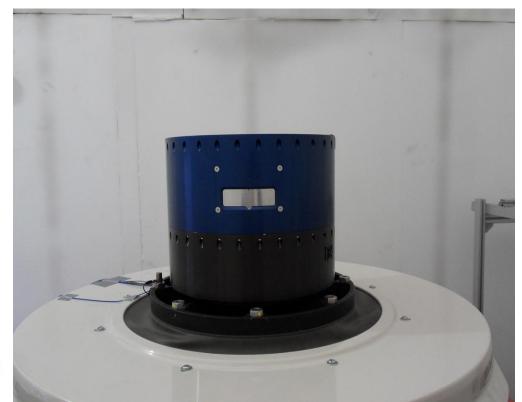


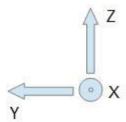
Picture 5: Test organisation, X-Axis





Picture 6: Test organisation, Y-Axis





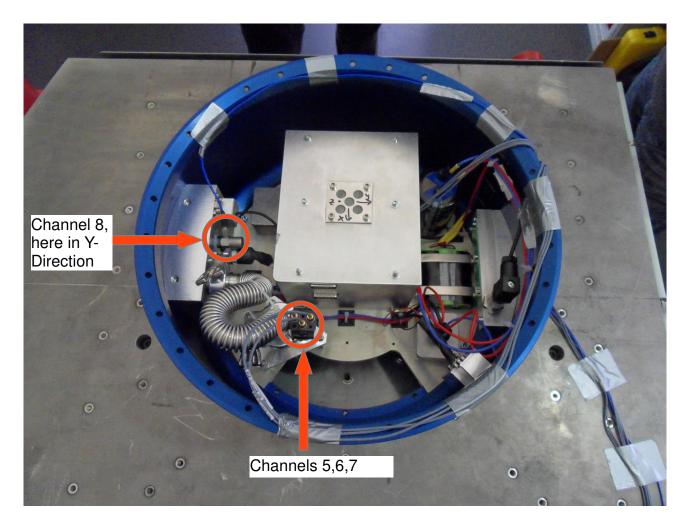
Picture 7: Test organisation, Z-Axis

# Monitoring of the incoming power flux

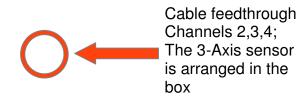
The incoming power was measured for each test by an acceleration sensor (type PCB-353B03). The sensor was mounted on the Hatch close to the module always in the direction of the axis which was under investigation. The Hatch perfectly suites for this application due to it's rigid fixation.

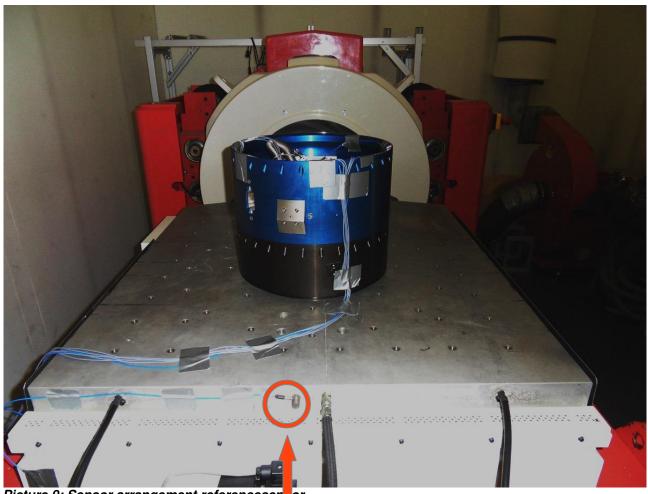
# Sensors, Positions, Channeloccupation und Fixing

Sensor Nr.	Туре	Measuring direction	Channel	Position, Function	Fixing
A-1	PCB-353B03	Uniaxial	1	Vibration desk, oscillation bin; in each direction of excitation, Referencesensor for the power output	Screwed
M-1	Brüel&Kjaer 4505A triaxial CCLD	X,Y,Z	2(X),3(Y), 4(Z)	In the electronic box, of the third platine from below	Sticked (hot glue)
M-2	Brüel&Kjaer 4505A triaxial CCLD	X,Y,Z	5(X),6(Y), 7(Z)	On the hose clamp of the Pirani- Sensors	Sticked (hot glue)
R-1	PCB-353B03	Uniaxial	8	Hatch, in each direction of excitation, referencesensor for the power input	Sticked (wax)



Picture 8: Sensor arrangement, X-Axis





Picture 9: Sensor arrangement referencesen or

Channel 1, Referencesensor in

### **Testlevels**

The test procedure and the test levels were set and defined on the bases of intense discussions and consultations with Mr Dieter Bischoff (ZARM Bremen) prior to the execution of the experiments.

# Eigenfrequencies searching

Sinus Eigenfrequencies searching			
Axis	Frequency spectrum	Input level	
X,Y	5-2000 Hz	0,25g	
Z	5-2000 Hz	0,5g	
Sweep Rate:	2 Oc	t/min	

#### Randomstrain

Random			
Axis	Frequency spectrum	Input Level	
All Axis	20-2000 Hz	6,34gRMS - 0,018g <sup>2</sup> /Hz	
Duration: %-Input:	10s/10s/10s/60s 25%/50%/75%/100%		

#### Results

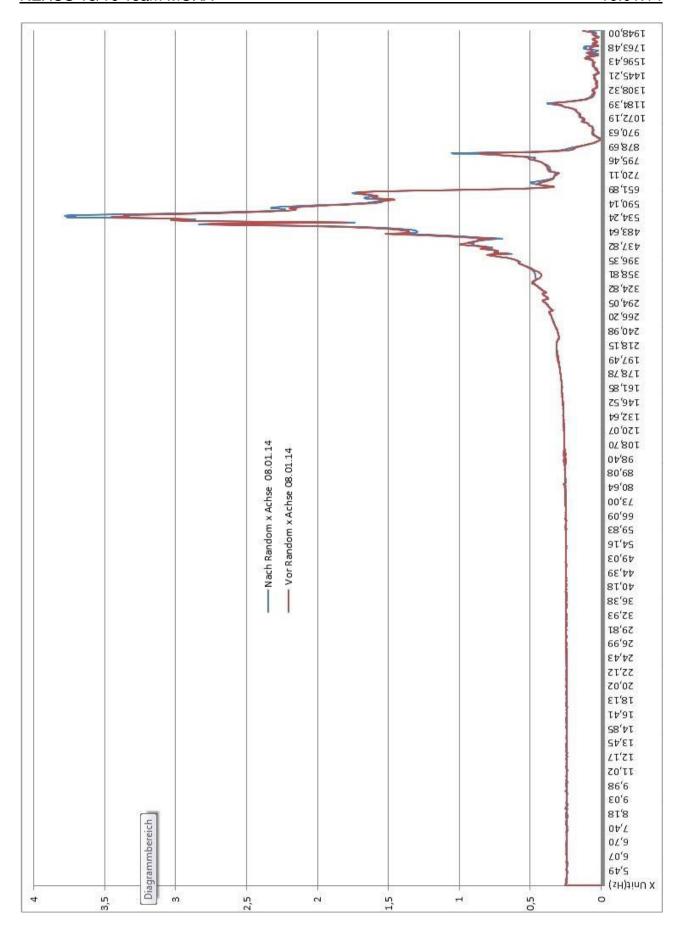
In the following subsection the eigen frequencies of the respective axis are given. Concerning the structural investigations, only eigen frequencies lower than 1000 Hz are of interest. The data of measurements conducted under higher frequencies would not be very precise due to smaller amplitudes. Because of this fact the software finds eigen frequencies which differ extremely from measurement to measurement. Concerning these findings the graphs, which plot the eigen frequency of the two measurements, are of significance.

#### X-Axis

After the first test measurements of the shaker were conducted, the scan for the eigen frequency of the x axis from 5 to 2000Hz with 0.25g was started. Concerning the structural analysis the first three eigen frequencies are of interest:

Time	Eigen frequency before Random	Eigen frequency after Random
00:00:02	Start at 5,00 Hz	Start at 5,00 Hz
00:03:26	514,30 Hz	512,79 Hz
00:03:29	538,95 Hz	545,30 Hz
00:03:47	840,94 Hz	840,94 Hz
00:03:51	926,22 Hz	-
00:04:02	1194,83 Hz	-
00:04:07	1312,15 Hz	-
00:04:09	1379,09 Hz	-
00:04:11	1428,39 Hz	-
00:04:13	1518,94 Hz	-
00:04:16	1643,85 Hz	-

We assume a very stiff constriction of our module due to the fact that the eigen frequencies are found at 514 and 539 Hertz. The eigen frequency plots before and after the Randomtest in direction of the x-axis are within the range of errors identical. The eigen frequencies show only small shifts and are position within the rage of errors of  $\pm$  5%. Also the strain of the eigen frequencies are within the range of errors of  $\pm$ 25%.

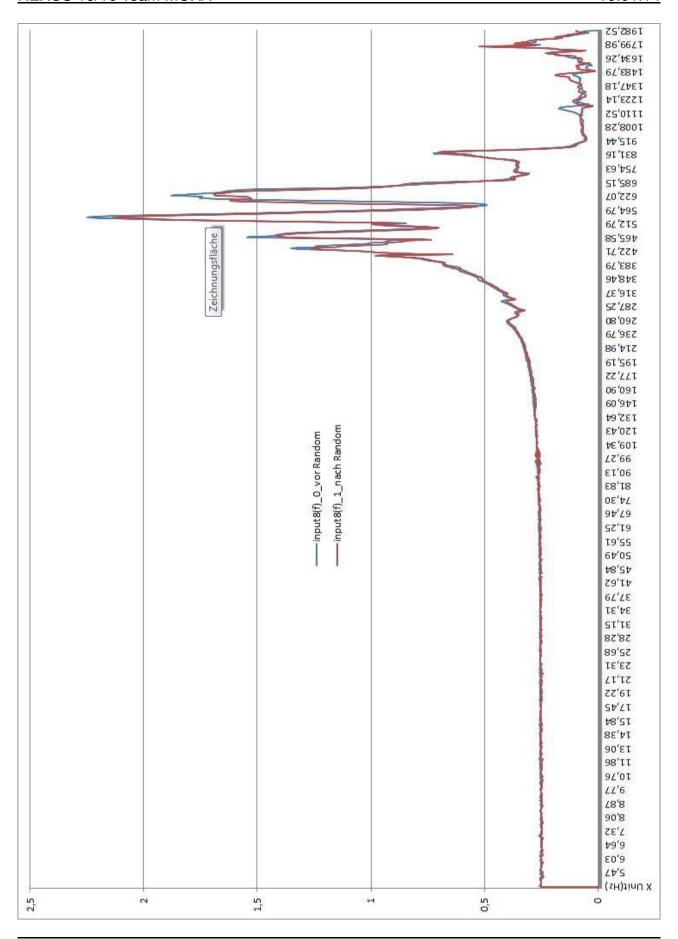


### Y-Axis

The search of the eigen frequency using 0.25g in the range of 5–2000 Hz in direction of the y-axis leads to the following results:

Time	Eigen frequency before Random	Eigen frequency after Random
00:00:02	Start at 5,00 Hz	Start at 5,00 Hz
00:03:16	414,14 Hz	414,14 Hz
00:03:21	435,17 Hz	435,27Hz
00:03:24	471,06 Hz	469,69 Hz
00:03:29	538,95 Hz	540,53 Hz
00:03:33	605,90 Hz	609,45 Hz
00:03:36	629,39 Hz	627,55 Hz
00:03:48	843,41 Hz	850,85 Hz
00:04:02	1146,86 Hz	-
00:04:04	1230,32 Hz	-
00:04:07	1312,15 Hz	-

Also in this case the eigen frequency is quite high. The comparison of the eigen frequency shows good match with the eigen frequencies gained under strain.

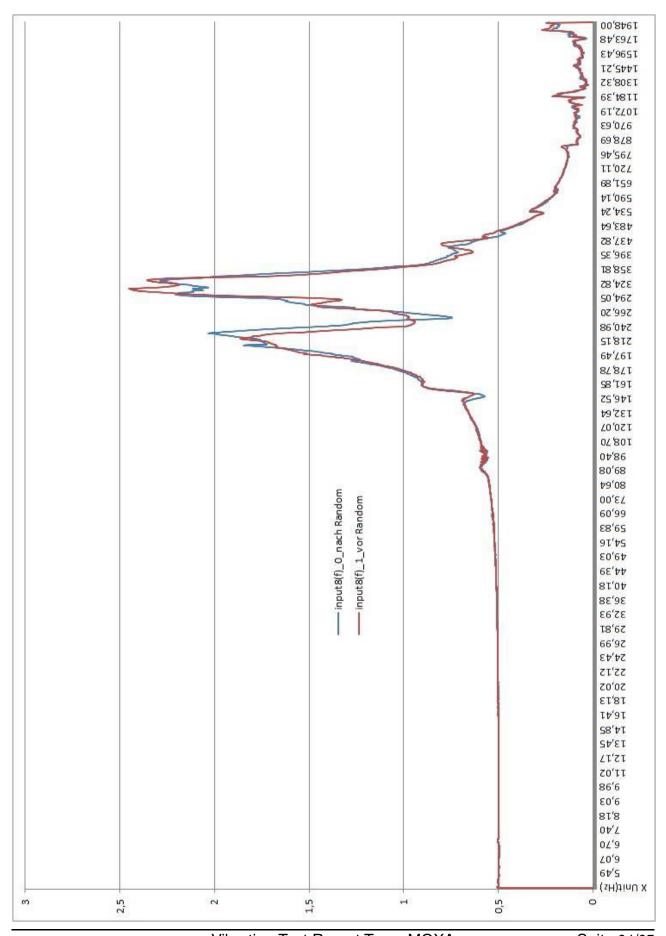


#### **Z-Axis**

After the conversion of the shaker for the tests in direction of the Z-axis, eigen frequency test runs were conducted. Due to the fact the first test runs couldn't be executed over the hole frequency spectrum (section 8.1), the strain was changed from 0.25 to 0.5g, still also in this case the test was conducted from 5 to 2000 Hz. The following eigen frequencies were found:

Time	Eigen frequency Before	Eigen frequency After
00:00:02	Start at 5,00 Hz	Start at 5,00 Hz
00:02:35	223,32 Hz	231,98 Hz
00:03:09	314,53 Hz	331,54 Hz
00:03:56	1156,97 Hz	-
00:04:00	1198,33 Hz	-
00:04:02	1278,04 Hz	-
00:04:03	1304,49 Hz	-
00:04:06	1483,79 Hz	-
00:04:14	1753,19 Hz	-
00:04:15	1886,28 Hz	-

During comparison of the eigen frequency curves before and after the randomtest we noticed that the graves are similar but they are shifts in the values of the eigen frequencies. These values are within the range of  $\pm 5\%$  and details are shown in section 8.2.



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#### Evaluation on the test measurements and discussion

### Z-Axis – Finding the eigen frequency using 0,25g

As mentioned in Section 7.3, during the test measurement, which should determine the eigen frequency in the direction of the Z-axis, a measurement error occurred. The shaker did start the search for the eigen frequency but stopped the measurement to early at 1500 Hz.

After an intense searching for errors and multiple restarts of the measurement using different measurement parameters, it was obvious that the problem in not solvable in easy manner. The only possibility to enable the measurement of the frequency response of the device to 2000 Hz is to increase the strain level. Alternatively we wouldn't gain any information in the frequency range of 1500 to 2000 Hz. The fact that all axis had been investigated in the range of 5 to 2000 Hz and no problems for the other measurements were found, the decision was made to increase the strain level to 0,5 gramm.

### Comparison of eigen frequencies

Due to the fact that the shifts of the eigen frequency of the X and Y-axis had been very small it can be assumed that no measurement errors concerning the stiffness occurred. The visual control and the check during demounting showed no measurement errors. The visual control after the test of the z-axis measurement showed no signs of stability problems. The only thing which was suspicious was a rattling noise occurring during the last tests. During the following demounting we noticed that the screws of the cap of the electronic box became loose and these screws are responsible for the irregular noise and for the displacement of the graphs.

But this isn't a problem for the experiment, because all screws are secured before the final mounting with screw locking. Furthermore the screws of the electronic box were already strained by many tests in X- and Y-direction before and due to this fact loosening occurred.

An unwanted loosening of the screw connection during the flight can be excluded if the mounting with done properly and screw locking is used. Therefore the necessary safety concerning the stability of our module is given.

### Opening of the Hatch

The independent opening of the Hatch during the Randomtest illustrates the problem which is multiple appeared. For this the interlocking system was optimized between the tests. We can conclude that this leads to an extension of the time which it takes to until it opens by itself. This does not lead to a solution of the problem.

If the Hatch is opened to early, the sensors can get contaminated or damaged due to particle from the rocket or air turbulences. The Randomtest was executed without a power enhancement but with maximal vibration power of 0,018 g²/Hz and with duration of 30 seconds to analyze the behavior of the module during the flight. The tests show that the hatchway opens itself around 3-5 seconds after start.

But the rotation of the rocket knits against this effect. The centrifugal force which results of this effect knits in the same axis like the bolt of the electromagnet of the closing device. Due to differences in storage life no defined vibration profile was found and therefore also the turn-on behavior of each motor is different. The position of the MOXA experiment on the rocket also decreases the impact of a to early opened hatch. Only the experiment of the team HORACE is positioned along the axis of height above the MOXA module. Furthermore no additional experiments are conducted by the team HORACE outside of the module. Therefore we don't expect any problems.

Even thought we can't determine the exact point in time when the hatch opens, we can be sure that in any case no problems should occur.

### **Facit**

The results of the vibration test shows that the module and the experimental set-up have a very rigid behavior and that only the interlocking system reacts sensitive of the vibration.

Searching for the eigen frequencies with different arrangement of damper on the fixture of the Pirani-sensor results for the team intern interests information about the damper behavior at this component.

It should be realized that the interlocking system using a brad and an electromagnet doesn't demonstrate an optimal solution.

The reliability of the experiment could be warranted for the allowed vibration load.

Nathanael Warth, Responsible person

Alexander Mager, Team leader

www.rexus-moxa.de



Students Experiment Document. MOXA Experiment RX16. TU Dresden.

### **APPENDIX F – PREPARATION AND TEST ACTIVITIES AT ESRANGE**